MITSUBISHI

Q2A(S1)/Q3A/Q4ACPU User's Manual (Hardware)

Mitsubishi Programmable Controller

User's Manual

(Hardware)

Thank you for purchasing the Mitsubishi programmable controller MELSEC-QnA series.

Prior to use, please read both this and relevant manuals thoroughly to fully understand the product.



MODEL	QNACPU-U(H/W)-E				
MODEL CODE	13J820				
IB-66607-I(0907)MEE					

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SAFETY PRECAUTIONS ●

(Be sure to read these instructions before use.)

Before using the product, read this and relevant manuals carefully and handle the product correctly with full attention to safety.

In this manual, ● SAFETY PRECAUTIONS ●are classified into 2 levels: "DANGER" and "CAUTION".



Indicates that incorrect handling may cause hazardous conditions, resulting in death or severe injury.



Indicates that incorrect handling may cause hazardous conditions, resulting in minor or moderate injury and/or property damage.

Under some circumstances, failure to observe the **CAUTION** level instructions may also lead to serious results.

Be sure to observe the instructions of both levels to ensure the safety.

Please keep this manual in a safe place for future reference and also pass this manual on to the end user.

[DESIGN PRECAUTIONS]

(!) DANGER

- Create a safety circuit outside the PLC to ensure the whole system will operate safely even if an external power failure or a PLC failure occurs. Otherwise, incorrect output or malfunction may cause an accident.
 - (1) For an emergency stop circuit, protection circuit and interlock circuit that is designed for incompatible actions such as forward/reverse rotation or for damage prevention such as the upper/lower limit setting in positioning, any of them must be created outside the PLC.
 - (2) When the PLC detects the following error conditions, it stops the operation and turn off all the outputs.
 - The overcurrent protection device or overvoltage protection device of the power supply module is activated.
 - The PLC CPU detects an error such as a watchdog timer error by the self-diagnostics function.

In the case of an error of a part such as an I/O control part that cannot be detected by the PLC CPU, all the outputs may turn on. In order to make all machines operate safely in such a case, set up a fail-safe circuit or a specific mechanism outside the PLC.

Refer to "LOADING AND INSTALLATION" in this manual for example fail safe circuits.

[DESIGN PRECAUTIONS]

! DANGER

- (3) Depending on the failure of the output module's relay or transistor, the output status may remain ON or OFF incorrectly. For output signals that may lead to a serious accident, create an external monitoring circuit.
- If load current more than the rating or overcurrent due to a short circuit in the load has flowed in the output module for a long time, it may cause a fire and smoke. Provide an external safety device such as a fuse.
- Design a circuit so that the external power will be supplied after power-up of the PLC.
 - Activating the external power supply prior to the PLC may result in an accident due to incorrect output or malfunction.
- For the operation status of each station at a communication error in data link, refer to the respective data link manual.
 - The communication error may result in an accident due to incorrect output or malfunction.
- When controlling a running PLC (data modification) by connecting a
 peripheral device to the CPU module or a PC to a special function module,
 create an interlock circuit on sequence programs so that the whole system
 functions safely all the time.
 - Also, before performing any other controls (e.g. program modification, operating status change (status control)), read the manual carefully and ensure the safety.
 - In these controls, especially the one from an external device to a PLC in a remote location, some PLC side problem may not be resolved immediately due to failure of data communications.
 - To prevent this, create an interlock circuit on sequence programs and establish corrective procedures for communication failure between the external device and the PLC CPU.
- When setting up the system, do not allow any empty slot on the base unit.
 If any slot is left empty, be sure to use a blank cover (AG60) or a dummy module (AG62) for it.
 - When using the extension base unit, A52B, A55B or A58B, attach the included dustproof cover to the module in slot 0.
 - Otherwise, internal parts of the module may be flied in the short circuit test or when an overcurrent or overvoltage is accidentally applied to external I/O section.

! CAUTION

 Do not install the control lines or communication cables together with the main circuit or power lines, or bring them close to each other.
 Keep a distance of 100mm (3.94inch) or more between them.
 Failure to do so may cause malfunctions due to noise.

[DESIGN PRECAUTIONS]

! CAUTION

- If having read register R outside the allowable range with the MOV instruction, the file register data will be FFFFH. Using this as it is may cause malfunctions. Pay attention not to use any out-of-range file register when designing sequence programs. For instruction details, refer to the programming manual.
- When an output module is used to control the lamp load, heater, solenoid valve, etc., a large current (ten times larger than the normal one) may flow at the time that the output status changes from OFF to ON. Take some preventive measures such as replacing the output module with the one of a suitable current rating.

[INSTALLATION PRECAUTIONS]

! CAUTION

- Use the PLC under the environment specified in the user's manual.
 Otherwise, it may cause electric shocks, fires, malfunctions, product deterioration or damage.
- Hold down the module loading lever at the module bottom, and securely insert the module fixing latch into the fixing hole in the base unit. Incorrect loading of the module can cause a malfunction, failure or drop. When using the PLC in the environment of much vibration, tighten the module with a screw.
 - Tighten the screw in the specified torque range. Undertightening can cause a drop, short circuit or malfunction. Overtightening can cause a drop, short circuit or malfunction due to damage to the screw or module.
- Connect the extension cable to the connector of the base unit or module.
 Check the cable for incomplete connection after connecting it.
 Poor electrical contact may cause incorrect inputs and/or outputs.
- Insert the memory card and fully press it to the memory card connector.
 Check for incomplete connection after installing it.
 Poor electrical contact may cause malfunctions.
- Be sure to shut off all phases of the external power supply used by the system before mounting or removing the module. Failure to do so may damage the module.
- Do not directly touch the conductive part or electronic components of the module.
 - Doing so may cause malfunctions or a failure of the module.

[WIRING PRECAUTIONS]

(!) DANGER

 Be sure to shut off all phases of the external power supply used by the system before wiring.

Failure to do so may result in an electric shock or damage of the product.

[WIRING PRECAUTIONS]

! DANGER

 Before energizing and operating the system after wiring, be sure to attach the terminal cover supplied with the product.

Failure to do so may cause an electric shock.

! CAUTION

- Always ground the FG and LG terminals to the protective ground conductor.
 Failure to do so may cause an electric shock or malfunctions.
- Wire the module correctly after confirming the rated voltage and terminal layout.
 - Connecting a power supply of a different voltage rating or incorrect wiring may cause a fire or failure.
- Do not connect multiple power supply modules to one module in parallel. The power supply modules may be heated, resulting in a fire or failure.
- Press, crimp or properly solder the connector for external connection with the specified tool.
 - Incomplete connection may cause a short circuit, fire or malfunctions.
- Tighten terminal screws within the specified torque range. If the screw is too loose, it may cause a short circuit, fire or malfunctions.
 - If too tight, it may damage the screw and/or the module, resulting in a short circuit or malfunctions.
- Carefully prevent foreign matter such as dust or wire chips from entering the module.
 - Failure to do so may cause a fire, failure or malfunctions.
- Install our PLC in a control panel for use.
 - Wire the main power supply to the power supply module installed in a control panel through a distribution terminal block.
 - Furthermore, the wiring and replacement of a power supply module have to be performed by a maintenance worker who acquainted with shock protection.
 - (For the wiring methods, refer to Q2ACPU(S1)/ Q3ACPU /Q4ACPU User's Manual)

[STARTUP AND MAINTENANCE PRECAUTIONS]

<!> DANGER

- Do not touch any terminal during power distribution.
 Doing so may cause an electric shock.
- Properly connect batteries. Do not charge, disassemble, heat or throw them into the fire and do not make them short-circuited and soldered. Incorrect battery handling may cause personal injuries or a fire due to exothermic heat, burst and/or ignition.

[STARTUP AND MAINTENANCE PRECAUTIONS]

(!) DANGER

 Be sure to shut off all phases of the external power supply used by the system before cleaning or retightening the terminal screws or module mounting screws.

Failure to do so may result in an electric shock.

If they are too loose, it may cause a short circuit or malfunctions.

If too tight, it may cause damage to the screws and/or module, resulting in an accidental drop of the module, short circuit or malfunctions.

! CAUTION

- When performing online operations (especially, program modification, forced output or operating status change) by connecting a peripheral device to the running CPU module, read the manual carefully and ensure the safety. Incorrect operation will cause mechanical damage or accidents.
- Do not disassemble or modify each of modules.
 Doing so may cause failure, malfunctions, personal injuries and/or a fire.
- When using a wireless communication device such as a mobile phone, keep a distance of 25cm (9.84inch) or more from the PLC in all directions.
 Failure to do so may cause malfunctions.
- Be sure to shut off all phases of the external power supply used by the system before mounting or removing the module.
 Failure to do so may result in failure or malfunctions of the module.
- When replacing the fuse, use a fuse specified by the manufacturer.
 Using the one for the high-rated current or an electric wire may cause a fire.
- Do not drop or apply any impact to the battery.
 Doing so may damage the battery, resulting in electrolyte spillage inside the battery.
 - If any impact has been applied, discard the battery and never use it.
- Before handling modules, touch a grounded metal object to discharge the static electricity from the human body.
 - Failure to do so may cause failure or malfunctions of the module.

[DISPOSAL PRECAUTIONS]

! CAUTION

When disposing of this product, treat it as an industrial waste.
 When disposing of batteries, separate them from other wastes according to the local regulations.

(For details of the Battery Directive in EU member states, refer to the Q2ACPU(S1)/Q3ACPU/Q4ACPU User's Manual.)

[TRANSPORTATION PRECAUTIONS]

! CAUTION

 When transporting lithium batteries, make sure to treat them based on the transportation regulations. (Refer to Chapter 7 for details of the relevant models.)

REVISIONS

*The manual number is given on the bottom right of the front cover.

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		SAFETY PRECAUTIONS, Section 1.1, Chapter 3, Section 4.3.2, 6.3
	l	

Japanese Manual Version IB-68503-K

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This manual describes the operating precautions, input/output connections, and error codes relavant to Q2ACPU, Q2ACPU-S1, Q3ACPU, and Q4ACPU (hereafter, all are referred to simply as "QnACPU") operations.

Manuals:

The following table list the manuals relevant to this product. Please order it as necessary.

Detailed manuals

Manual Name	Manual No.
Q2ACPU(S1)/Q3ACPU/Q4ACPU User's Manual Discusses QnACPU performance, functions, and operation, and contains the specifications for the power supply, memory card, and base unit. (sold separately)	IB-66608 (13J821)

Related manuals

Manual Name	Manual No.
QnACPU Guidebook This manual is designed for first-time users of the QnACPU. It explains the procedures for all operations from program creation, to program writing to the CPU, and program debugging. It also explains how to use the QnACPU special features. (sold separately)	IB-66606 (13JF10)
QnACPU Programming Manual (Fundamentals) This manual explains the programming procedures required for program creation. It also explains the device names, parameters, and program types. (sold separately)	IB-66614 (13JF46)
QCPU(Q mode)/QnACPU Programming Manual (Common Instructions) This manual explains how to use the sequence instructions, basic instructions, and application instructions. (sold separately)	SH-080039 (13JF58)
QnACPU Programming Manual (Special Function Module) This manual explains the dedicated instructions used with special function modules. (sold separately)	SH-4013 (13JF56)
QnACPU Programming Manual (AD57 Instructions) This manual explains the dedicated instructions used to operate the AD57(S1) CRT controller module. (sold separately)	IB-66617 (13JF49)
QCPU(Q mode)/QnACPU Programming Manual (PID Control Instructions) This manual explains the dedicated instructions used to execute PID control. (sold separately)	SH-080040 (13JF59)
QCPU(Q mode)/QnACPU Programming module (SFC) This manual explains the system configuration, performance specifications, functions, programming, debugging error codes and others of MELSAP3. (sold separately)	SH-080041 (13JF60)
I/O module type Building block User's Manual This manual gives the specifications for building- block type I/O modules. (sold separately)	IB-66140 (13J643)

1. SPECIFICATIONS

1.1 SPECIFICATIONS

Table 1.1 General specification

Item	Specifications					
Ambient operating temperature		0 to 55 °C				
Ambient storage temperature			–20 to 7	75 °C		
Ambient operating humidity		10	to 90 % RH, N	No-condensing		
Ambient storage humidity		10	to 90 % RH, N	No-condensing		
			Frequency	Acceleration	Amplitude	No. of sweeps
Vibration	Conforming	Under intermittent	10 to 57Hz		0.075mm (0.003in.)	10 times each in
resistance to JIS B 3502 IEC 61131-2	to JIS B 3502, IEC 61131-2	JIS B 3502, vibration	57 to 150Hz	9.8m/s ²		X, Y, Z directions
		Under continuous	10 to 57Hz		0. 035mm (0.001in.)	
		vibration	57 to 150Hz	4.9m/s ²		
Shock resistance		Conforming to JIS B 3502, IEC 61131-2 (147 m/s ² , 3 times in each of 3 directions X, Y, Z)				
Operating ambience		No corrosive gases				
Operating elevation *3		2000m (6562ft.) max.				
Installation location	Control panel					
Over voltage category *1	II max.					
Pollution level *2			2 ma	ax.		
Equipment category			Clas	sl		

- *1: This indicates the section of the power supply to which the equipment is assumed to be connected between the public electrical power distribution network and the machinery within premises. Category II applies to equipment for which electrical power is supplied from fixed facilities. The surge voltage withstand level for up to the rated voltage of 300 V is 2500 V.
- *2: This index indicates the degree to which conductive material is generated in terms of the environment in which the equipment is used. Pollution level 2 is when only non-conductive pollution occurs. A temporary conductivity caused by condensing must be expected occasionally.
- *3: Do not use or store the PLC in the environment when the pressure is higher than the atmospheric pressure at sea level. Otherwise, malfunction may result. To use the PLC in high-pressure environment, contact your nearest Mitsubishi representative.

2. PERFORMANCE SPECIFICATIONS

2.1 QnACPU Module Performance Specifications

This section gives the Performance specifications of the QnACPU.

Table 2.1 Performance Specifications

Item		Model Name						
		Q2ACPU	Q2ACPU-S1	Q3ACPU	Q4ACPU	Remark		
Control system		Repeat	Repeated operation (using stored program)					
I/O control method		Refresh mode				Direct input using device names possible		
			Langu	lage dedicated	to sequence	control		
Programming	g languag	e	Relay sym	ibol language, MELSAP		language,		
Processing s	need	LD	02.4	s/step	0.15	0.075		
(sequence	peeu	LD	0.2 p	(5/5(ep	μs/step	μs/step		
instruction)		MOV	06.4	s/step	0.45	0.225		
instruction)		IVIOV	υ.υ μ	13/316p	μs/step	μs/step		
Constant sca at fixed time		m started	5 to 2	5 to 2000 ms (can be set in 5 ms units)				
Memory cap	Memory capacity		Capacity of the installed memory card (max. 2036 k bytes)					
Drogram	Number	of stone	Max. 28 k	Max. 60 k	Max. 92 k	Max. 124 k		
Program capacity	Number of steps		steps	steps	steps	steps		
Сарасну	Number	of files	28 files	60 files	92 files	124 files		
Number of I/O device points		points	8192 points (X/Y0 to 1FFF)				Number of points that can be used in programs	
Number of I/O points		512 points (X/Y0 to 1FF)	1024 points (X/Y0 to 3FF)	2048 points (X/Y0 to 7FF)	4096 points (X/Y0 to FFF)	Number of points actually accessible with I/O modules		
Clock function		Year, month, date, hour, minute, second, day of week (automatic recognition of leap years) Accuracy -2.3 to +4.4 s (TYP. +1.8 s)/d at 0 °C Accuracy -1.1 to +4.4 s (TYP. +2.2 s)/d at 25°C Accuracy -9.6 to +2.7 s (TYP2.4 s)/d at 55 °C			ears) s)/d at 0 °C s)/d at 25°C			
Allowable momentary power interruption time			Depo	ends on the po	wer supply mo	odule		

Table 2.1 Performance Specifications (Continued)

Item	Model Name				Remark
item	Q2ACPU	Q2ACPU-S1	Q3ACPU	Q4ACPU	Remark
Internal current consumption for 5 VDC	0.3 (0.4) A	0.3 (0.4) A	0.3 (0.4) A	0.6 (0.9) A	The numerical value in parentheses represents a function version "B" or later unit.
Weight	0.8 kg	0.8 kg	0.8 kg	0.8 kg	
External dimensions	250(H) (9.84) × 79.5(W) (3.13) × 121(D) (4.76) mm (inch)				

REMARK

Please check the rating plate of the CPU module for the function version "B".

<QnACPU>



3. EMC DIRECTIVES AND LOW VOLTAGE DIRECTIVES

The products sold in the European countries have been required by law to comply with the EMC Directives and Low Voltage Directives of the EU Directives since 1996 and 1997, respectively.

The manufacturers must confirm by self-declaration that their products meet the requirements of these directives, and put the CE mark on the products.

(1) Authorized representative in Europe

Authorized representative in Europe is shown below.

Name: Mitsubishi Electric Europe BV

Address: Gothaer strase 8, 40880 Ratingen, Germany

3.1 Requirements for Compliance with EMC Directives

The EMC Directives specifies emission and immunity criteria and requires the products to meet both of them, i.e., not to emit excessive electromagnetic interference (emission): to be immune to electromagnetic interference outside (immunity).

Guidelines for complying the machinery including MELSEC-QnA series PLC with the EMC Directives are provided in Section 3.1.1 to 3.1.6 below.

The guidelines are created based on the requirements of the regulations and relevant standards, however, they do not guarantee that the machinery constructed according to them will not comply with the Directives.

Therefore, the manufacturer of the machinery must finally determine how to make it comply with the EMC Directives: if it is actually compliant with the EMC Directives.

3.1.1 EMC standards

When the PLC is installed following the directions given in this manual its EMC performance is compliant to the following standards and levels as required by the EMC directive.

Specifications	Test Item	Test Description	Standard Values
EN61000-6-4	EN55011 *2 Radiated noise	Measure the emission released by the product.	30M-230 M Hz QP: 30dBμ V/m (30m measurement) *1 230M-1000MHz QP: 37dBμ V/m (30m measurement) *1
(2001)	EN55011 *2 Conduction noise	Measure the emission released by the product to the power line.	150k-500kHz QP: 79dB, Mean: 66dB*1 500k-30MHz QP: 73dB, Mean: 60dB *1
	EN61000-4-2 *2 Static electricity immunity	Immunity test by applying static electricity to the module enclosure.	4kV contact discharge 8kV air discharge
EN61131-2/A12 (2000)	EN61000-4-4 *2 First transient burst noise	Immunity test by applying burst noise to the power line and signal line.	2kV Power line 1kv Signal line
	EN61000-4-12 *2 Damped oscillatory wave	Immunity test in which a damped oscillatory wave is superimposed on the power line.	1kv
	EN61000-4-3 *2 Radiated electromagnetic field	Immunity test by applying a radiated electric field to the product.	10V/m, 26-1000MHz
EN61000-6-2 (2001)	EN61000-4-6 *2 Conduction noise	Immunity test by inducting an electromagnetic field in the power line signal line.	10 V/ms, 0.15-80MHZ, 80% AM modulation@1kHz

^{*1:} QP: Quasi-peak value, Mean: Average value

The tests for the corresponding items were performed while the PLC was installed inside the control panel.

^{*2:} The PLC is an open type device (device installed to another device) and must be installed in a conductive control panel.

3.1.2 Installation instructions for EMC Directive

The PLC is open equipment and must be installed within a control cabinet for use.* This not only ensures safety but also ensues effective shielding of PLC-generated electromagnetic noise.

* : Also, each network remote station needs to be installed inside the control panel.

However, the waterproof type remote station can be installed outside the control panel.

- (1) Control cabinet
 - (a) Use a conductive control cabinet.
 - (b) When attaching the control cabinet's top plate or base plate, mask painting and weld so that good surface contact can be made between the cabinet and plate.
 - (c) To ensure good electrical contact with the control cabinet, mask the paint on the installation bolts of the inner plate in the control cabinet so that contact between surfaces can be ensured over the widest possible area.
 - (d) Earth the control cabinet with a thick wire so that a low impedance connection to ground can be ensured even at high frequencies.
 - (e) Holes made in the control cabinet must be 10 cm (3.94 in.) diameter or less. If the holes are 10 cm (3.94 in.) or larger, radio frequency noise may be emitted.
 - In addition, because radio waves leak through a clearance between the control panel door and the main unit, reduce the clearance as much as practicable.

The leakage of radio waves can be suppressed by the direct application of an EMI gasket on the paint surface.

Our tests have been carried out on a panel having the damping characteristics of 37 dB max. and 30 dB mean (measured by 3 m method with 30 to 300 MHz).

- (2) Connection of power and earth wires

 Earthing and power supply wires for the PLC system must be connected as described below.
 - (a) Provide an earthing point near the power supply module. Earth the power supply's LG and FG terminals (LG: Line Ground, FG: Frame Ground) with the thickest and shortest wire possible. (The wire length must be 30 cm (11.18 in.) or shorter.) The LG and FG terminals function is to pass the noise generated in the PLC system to the ground, so an impedance that is as low as possible must be ensured. In addition, make sure to wire the ground cable short as the wires are used to relieve the noise, the wire itself carries large noise content and thus short wiring means that the wire is prevented from acting as an antenna.
 - (b) The earth wire led from the earthing point must be twisted with the power supply wires. By twisting with the earthing wire, noise flowing from the power supply wires can be relieved to the earthing. However, if a filter is installed on the power supply wires, the wires and the earthing wire may not need to be twisted.

3.1.3 Cables

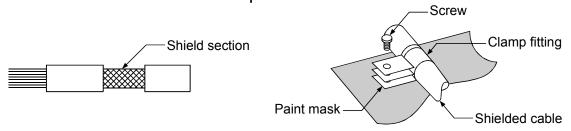
The cables pulled out of the control panel contain a high frequency noise component. On the outside of the control panel, therefore, they serve as antennas to emit noise.

Ensure to use shielded cables for the cables, which are connected to the I/O modules, special modules and those pulled out to outside of the control panel. Mounting ferrite core is not required except some types of CPU however, noise emanated via the cable can be restrained using it.

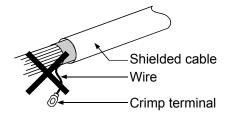
The use of a shielded cable also increases noise resistance. The signal lines (including common line) connected to the PLC input/output modules and intelligent modules use shielded cables to assure noise resistance, as a condition, standardized on EN61131-2/A12 (2000).

If a shielded cable is not used or not earthed correctly, the noise resistance will be less than the rated value

- (1) Earthing of shielded of cables
 - (a) Earth the shield of the shielded cable as near the unit as possible taking care so that the earthed cables are not induced electromagnetically by the cable to be earthed.
 - (b) Take appropriate measures so that the shield section of the shielded cable from which the outer cover was partly removed for exposure is earthed to the control panel on an increased contact surface. A clamp may also be used as shown in the figure below. In this case, however, apply a cover to the painted inner wall surface of the control panel which comes in contact with the clamp.

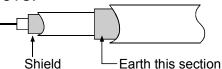


Note) The method of earthing by soldering a wire onto the shield section of the shielded cable as shown below is not recommended. The high frequency impedance will increase and the shield will be ineffective.

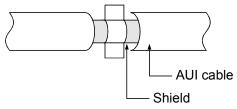


(2) MELSECNET (II) and MELSECNET/10 units

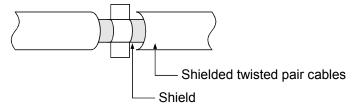
(a) Use a double-shielded coaxial cable for the MELSECNET unit which uses coaxial cables. Noise in the range of 30 MHz or higher in radiation noise can be suppressed by the use of double-shielded coaxial cables (Mitsubishi Cable: 5C-2V-CCY). Earth the outer shield to the ground. The precautions on shielding to be followed are the same as those stated in item (1) above.



- (b) Ensure to attach a ferrite core to the double-shielded coaxial cable connected to the MELSECNET unit. In addition, position the ferrite core on each cable near the outlet of the control panel. TDK-make ZCAT3035 ferrite core is recommended.
- (3) Ethernet module
 Precautions to be followed when AUI cables and coaxial cables are used are described below.
 - (a) Ensure to earth also the AUI cables connected to the 10BASE5 connectors of the AJ71QE71-B5. Because the AUI cable is of the shielded type, as shown in the figure below, partly remove the outer cover of it, and earth the exposed shield section to the ground on the widest contact surface.



(b) Use shielded twisted pair cables as the twisted pair cables*1 connected to the 10BASE-T connectors. For the shielded twisted pair cables, strip part of the outer cover and earth the exposed shield section to the ground on the widest contact surface as shown below.

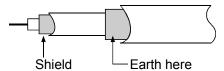


Refer to (1) for the earthing of the shield.

*1: Make sure to install a ferrite core for the cable.

As a ferrite core, ZCAT2035 manufactured by TDK is recommended.

(c) Always use double-shielded coaxial cables as the coaxial cables*2 connected to the 10BASE2 connectors. Earth the double-shielded coaxial cable by connecting its outer shield to the ground.



Refer to (1) for the earthing of the shield.

*2: Make sure to install a ferrite core for the cable.

As a ferrite core, ZCAT2035 manufactured by TDK is recommended.

Ethernet is the registered trademark of XEROX, Co.,LTD

(4) I/O and other communication cables

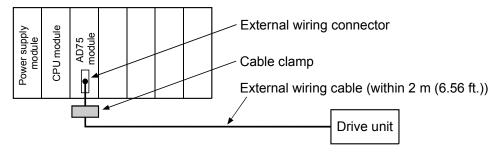
For the I/O signal lines (including common line) and other communication cables (RS-232, RS-422, etc), if extracted to the outside of the control panel, also ensure to earth the shield section of these lines and cables in the same manner as in item (1) above.

(5) Positioning Modules

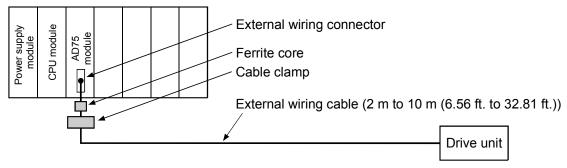
Precautions to be followed when the machinery conforming to the EMC Directive is configured using the AD75P

-S3 are described below.

- (a) When wiring with a 2 m (6.56 ft.) or less cable
 - Ground the shield section of the external wiring cable with the cable clamp.
 - (Ground the shield at the closest location to the AD75 external wiring connector.)
 - Wire the external wiring cable to the drive unit and external device with the shortest practicable length of cable.
 - Install the drive unit in the same panel.



- (b) When wiring with cable that exceeds 2 m (6.56 ft.), but is 10 m (32.81 ft.) or less
 - Ground the shield section of the external wiring cable with the cable clamp.
 - (Ground the shield at the closest location to the AD75 external wiring connector.)
 - Install a ferrite core.
 - Wire the external wiring cable to the drive unit and external device with the shortest practicable length of cable.



(c) Ferrite core and cable clamp types and required quantities

Cable clamp

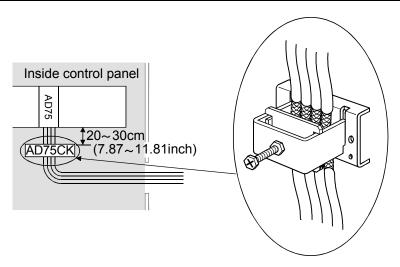
Type: AD75CK (Mitsubishi Electric)

• Ferrite core

Type: ZCAT3035-1330 (TDK ferrite core)

Required quantity

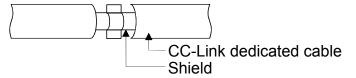
Cable length	Dropared part	Required Qty			
Cable length	Prepared part	1 axis	2 axes	3 axes	
Within 2 m (6.56 ft.)	AD75CK	1	1	1	
2 m (6 F6 ft) to 10m (22 91 ft)	AD75CK	1	1	1	
2 m (6.56 ft.) to 10m (32.81 ft.)	ZCAT3035-1330	1	2	3	



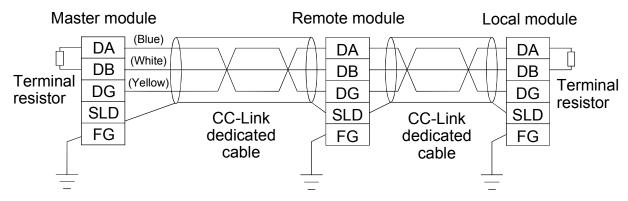
(6) CC-Link Module

(a) Be sure to ground the cable shield that is connected to the CC-Link module close to the exit of control panel or to any of the CC-Link stations within 30 cm (11.81 in.) from the module or stations.

The CC-Link dedicated cable is a shielded cable. As shown in the illustration below, remove a portion of the outer covering and ground as large a surface area of the exposed shield part as possible.



- (b) Always use the specified CC-Link dedicated cable.
- (c) The CC-Link module, the CC-Link stations and the FG line inside the control panel should be connected at the FG terminal as shown in the diagram below.



- (d) Power line connecting to the external power supply terminal (compliant with I/O power port of CE standard) should be 30m (98.43 ft.) or less. Power line connecting to module power supply terminal (compliant with main power port of CE standard) should be 10m (32.81 ft.) or less.
- (e) A power line connecting to the analog input of the following modules should be 30cm or less.
 - AJ65BT-64RD3
 - AJ65BT-64RD4
 - AJ65BT-68TD

3.1.4 Power supply module

The precautions required for each power supply module are described below. Always observe the items noted as precautions.

Model	Precautions		
A61P, A61PN, A62P	Use not allowed		
A63P	Use a CE-compliant 24VDC power supply in the control panel.		
A61PEU, A62PEU	Make sure to short and ground the LG and FG terminals.		

3.1.5 Base unit

The following table shows models of base units that are compatible with EMC instructions.

Туре	Model name	Applicability		
Main base unit	A38HBEU	Applicable		
I Wall base unit	A3□B, A38HB	Not applicable		
Extension base unit	A5□B, A6□B	Applicable		

3.1.6 Ferrite core

Use of ferrite cores is effective in reducing the conduction noise in the band of about 10 MHz and radiated noise in 30 to 100 MHz band.

It is recommended to attach ferrite cores when the shield of the shielded cable coming out of control panel does not work effectively, or when emission of the conduction noise from the power line has to be suppressed.*1 The ferrite cores used in our tests are TDK's ZCAT3035.

It should be noted that the ferrite cores should be fitted to the cables in the position immediately before they are pulled out of the enclosure. If the fitting position is improper, the ferrite will not produce any effect.

*1:To response with CE(EN61131-2/A12), make sure to mount 2 or more ferrite cores onto the power supply line. The mounting position should be as near the power supply module as possible.

Ferrite core

Type: ZCAT2235-1030A (TDK ferrite core)

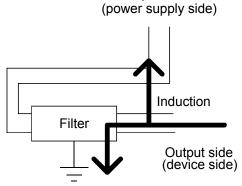
3.1.7 Noise filter (power supply line filter)

A noise filter is a component which has an effect on conducted noise. With the exception of some models, it is not required to fit the noise filter to the power supply line, but fitting it can further suppress noise. (The noise filter has the effect of reducing conducted noise of 10 M Hz or less.) Use any of the following noise filters (double π type filters) or equivalent.

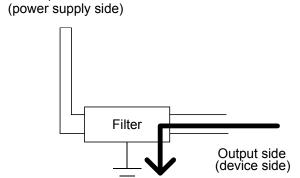
Model name	FN343-3/01	FN660-6/06	ZHC2203-11		
Manufacturer	SCHAFFNER	SCHAFFNER SCHAFFNER			
Rated current	3 A	3 A			
Rated voltage	250 V				

The precautions required when installing a noise filter are described below.

(1) Do not bundle the wires on the input side and output side of the noise filter. When bundled, the output side noise will be induced into the input side wires from which the noise was filtered.



(a) The noise will be included when the input and output wires are bundled.



(b) Separate and lay the input and output wires.

(2) Earth the noise filter earthing terminal to the control cabinet with the shortest wire possible (approx. 10 cm (3.94 in.)).

3.2 Requirements for Compliance with Low Voltage Directives

The Low Voltage Directives apply to the electrical equipment operating from 50 to 1000VAC or 75 to 1500VDC; the manufacturer must ensure the adequate safety of the equipment.

Guidelines for installation and wiring of MELSEC-QnA series PLC are provided in Section 3.2.1 to 3.2.7 for the purpose of compliance with the EMC Directives. The guidelines are created based on the requirements of the regulations and relevant standards, however, they do not guarantee that the machinery constructed according to them will comply with the Directives.

Therefore, the manufacturer of the machinery must finally determine how to make it comply with the EMC Directives: if it is actually compliant with the EMC Directives.

3.2.1 Standard applied for MELSEC-QnA series PLC

The standard applied for MELSEC-QnA series PLC series is EN61010-1 safety of devices used in measurement rooms, control rooms, or laboratories.

For the modules which operate with the rated voltage of 50 VAC/75 VDC or above, we have developed new models that conform to the above standard. For the modules which operate with the rated voltage under 50 VAC/75 VDC, the conventional models can be used, because they are out of the low voltage directive application range.

3.2.2 Precautions when using the MELSEC-QnA series PLC

Module selection

(1) Power module

For a power module with rated input voltage of 100/200 VAC, select a model in which the internal part between the first order and second order is intensively insulated, because it generates hazardous voltage (voltage of 42.4 V or more at the peak) area.

For a power module with 24 VDC rated input, a conventional model can be used.

(2) I/O module

For I/O module with rated input voltage of 100/200 VAC, select a model in which the internal area between the first order and second order is intensively insulated, because it has hazardous voltage area.

For I/O module with 24 VDC rated input, a conventional model can be used.

- (3) CPU module, memory cassette, base unit Conventional models can be used for these modules, because they only have a 5 VDC circuit inside.
- (4) Special function module Conventional models can be used for the special modules including analog module, network module, and positioning module, because the rated voltage is 24 VDC or smaller.
- (5) Display device
 Use the CE-marked product.

3.2.3 Power supply

The insulation specification of the power module was designed assuming installation category II. Be sure to use the installation category II power supply to the PLC. The installation category indicates the durability level against surge voltage generated by a thunderbolt. Category I has the lowest durability; category IV has the highest durability.

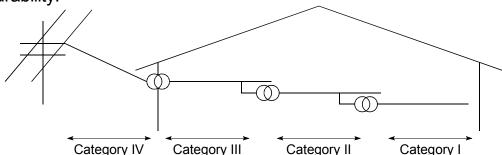


Figure 1.: Installation Category

Category II indicates a power supply whose voltage has been reduced by two or more levels of isolating transformers from the public power distribution.

3.2.4 Control panel

Because the PLC is an open device (a device designed to be stored within another module), be sure to use it after storing in the control panel.

- (1) Electrical shock prevention In order to prevent persons who are not familiar with the electric facility such as the operators from electric shocks, the control panel must have the following functions:
 - (a) The control panel must be equipped with a lock so that only the personnel who has studied about the electric facility and have enough knowledge can open it.
 - (b) The control panel must have a structure which automatically stops the power supply when the box is opened.
 - (c) For electric shock protection, use IP20 or greater control panel.
- (2) Dustproof and waterproof features

The control panel also has the dustproof and waterproof functions. Insufficient dustproof and waterproof features lower the insulation withstand voltage, resulting in insulation destruction. The insulation in our PLC is designed to cope with the pollution level 2, so use in an environment with pollution level 2 or below.

- Pollution level 1 : An environment where the air is dry and conductive dust does not exist.
- Pollution level 2: An environment where conductive dust does not usually exist, but occasional temporary conductivity occurs due to the accumulated dust. Generally, this is the level for inside the control panel equivalent to IP54 in a control room or on the floor of a typical factory.
- Pollution level 3: An environment where conductive dust exits and conductivity may be generated due to the accumulated dust.

 An environment for a typical factory floor.
- Pollution level 4 : Continuous conductivity may occur due to rain, snow, etc. An outdoor environment.

As shown above, the PLC can realize the pollution level 2 when stored in a control panel equivalent to IP54.

3.2.5 Module installation

(1) Installing modules contiguously

In Q2AS series PLCs, the left side of each I/O module is left open. When installing an I/O module to the base, do not make any open slots between any two modules. If there is an open slot on the left side of a module with 100/200 VAC rating, the printed board which contains the hazardous voltage circuit becomes bare. When it is unavoidable to make an open slot, be sure to install the blank module (AG60).

3.2.6 Grounding

There are two kinds of grounding terminals as shown below. Either grounding terminal must be used grounded.

Be sure to ground the protective grounding for the safety reasons.

Protective grounding (a): Maintains the safety of the PLC and improves

the noise resistance.

Functional grounding \triangle : Improves the noise resistance.

3.2.7 External wiring

(1) Module power supply and external power supply

For the remote module which requires 24VDC as module power supply, the 5/12/24/48VDC I/O module, and the intelligent function module (special function module) which requires the external power supply, use the 5/12/24/48VDC circuit which is doubly insulated from the hazardous voltage circuit or use the power supply whose insulation is reinforced.

(2) External devices

When a device with a hazardous voltage circuit is externally connected to the PLC, use a model whose circuit section of the interface to the PLC is intensively insulated from the hazardous voltage circuit.

(3) Intensive insulation

Intensive insulation refers to the insulation with the dielectric withstand voltage shown in Table 1.

Table 1: Intensive Insulation Withstand Voltage (Installation Category II, source: IEC664)

Rated voltage of hazardous voltage area	Surge withstand voltage (1.2/50 μs)
150 VAC or below	2500 V
300 VAC or below	4000 V

4. LOADING AND INSTALLATION

4.1 Installing modules

4.1.1 Precautions for handling of modules

This section describes the precautions that must be taken when handling the CPU, I/O modules, special function modules, power supply module, base units, etc.

- (1) Module enclosure, memory cassette, terminal block connectors and pin connectors are made of resin; do not drop them or subject them to strong impact.
- (2) Do not remove module's printed circuit boards from the plastic casing.
- (3) During wiring, take care to ensure that wiring off cuts, etc. do not get inside the case.
 - If anything does get inside the case, remove it.
- (4) Tighten the module mounting (unnecessary in normal operating condition) and terminal block screws as indicated below.

Screw	Tightening Torque N ⋅ cm			
Module mounting screws (M4 screw) (optional)	78 to 118			
Terminal block screws	98 to 137			

(5) To install a module, push it firmly into the base unit so that the latch engages properly. To remove a module, press the latch to disengage it from the base unit, then pull the module out (for details, refer to the relevant PLC CPU User's Manual).

4.1.2 Installation environment

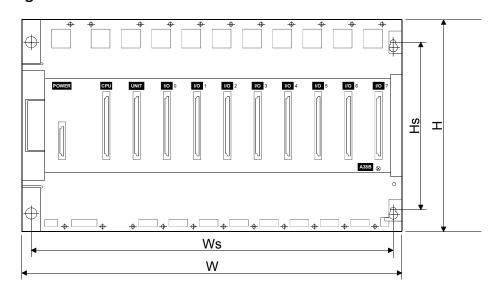
The CPU system should not be installed under the following environmental conditions:

- (1) Places where ambient temperature is outside of 0 to 55°C range.
- (2) Places where ambient humidity is outside of 10 to 90%RH range.
- (3) Places where dewing (condensation) occurs due to sudden temperature changes.
- (4) Places where corrosive or inflammable gas exists.
- (5) Places where a large amount of dust, iron powder and other conductive powder, oil mist, salt or organic solvent exists.
- (6) places exposed to direct sunlight.
- (7) Places where a strong electric or magnetic field exists.
- (8) Places where mechanical vibrations or impacts are transmitted directly to the module body.

4.1.3 Precautions relating to the installation of the unit

The following precautions must be observed when installing a PLC to an operation panel or other bases considering fully the operability, maintainability, and resistance to the environment.

(1) Mounting dimension Mounting dimensions of each base unit are as follows.

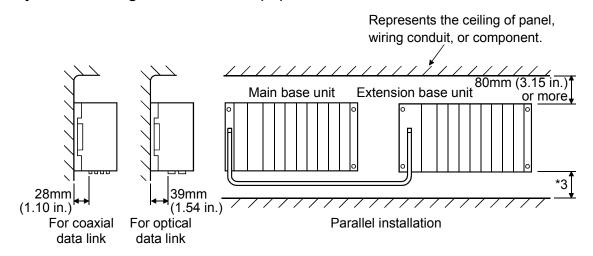


	A32B	A32B-S1	A35B	A38B A38HB	A62B	A65B	A68B	A52B	A55B	A58B
	A32D	AJZD-U1	7000	A38HBEU	A02D	AOOD	7000	7 32D	7000	AJOB
W	247	268	382	480	238	352	466	183	297	411
VV	(9.72)	(10.55)	(15.03)	(18.9)	(9.37)	(13.86)	(18.35)	(7.2)	(11.69)	(16.18)
Ws	227	248	362	460	218	332	446	163	277	391
VVS	(8.93)	(9.76)	(14.25)	(18.11)	(8.58)	(13.07)	(17.6)	(6.42)	(10.9)	(15.4)
Н	250 (9.84)									
Hs					200 (7.	87)				

Dimensions: mm (inch)

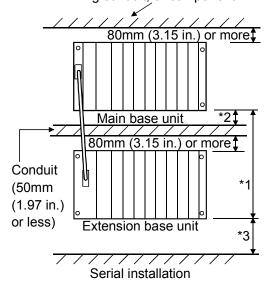
(2) Unit mounting position

To ensure proper ventilation and make module replacement easy, provide a clearance of 80 mm (3.15 in.) or more between the top of the unit and any surrounding structure or equipment.



- (3) A wiring conduit should be provided if required.
 - If its clearance above or below the programmable controller is less than indicated in the figure above, observe the following points:
 - (a) If the wiring conduit is installed above the programmable controller, its height must be no greater than 50 mm (1.97 in.) to ensure good ventilation.
 - In addition, there should be adequate space between the programmable controller and the wiring conduit to allow module latches to be pressed.
 - It will not be possible to replace modules if their latches cannot be pressed.
 - (b) If the wiring conduit is installed below the programmable controller, it should be installed so as to allow connection of the optical fiber cable or coaxial cable, taking the minimum bending radius of the cable into consideration.

Represents the ceiling of panel, wiring conduit, or component.

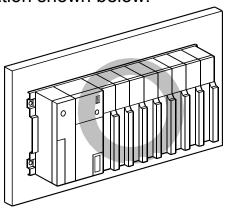


*1: These dimensions vary d	1: These dimensions vary depending on the length of the			
extension cable as follow	extension cable as follows:			
AC06B cable	. 450mm (17.71 in.) or less			
AC12B cable	. 1050mm (41.34 in.) or less			
AC30B cable	. 2850mm (112.20 in.) or less			
*2: When a link module is				
not used	. 50mm (1.97 in.) or more			
When using M 5mm				

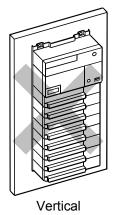
optical fiber cable 130mm (5.12 in.) or more

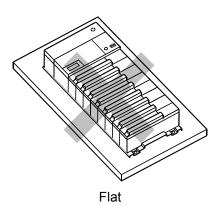
(4) Unit mounting orientation

(a) Since the PLC generates heat, mount it in a well-ventilated location and in the orientation shown below.



(b) Do not mount it in either of the orientations shown below.

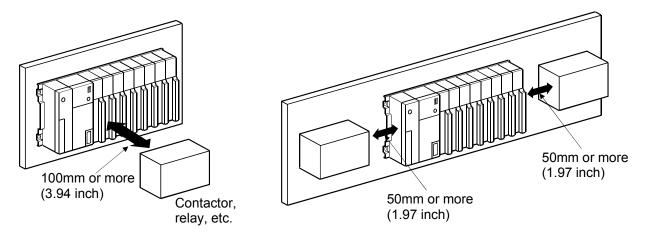




(5) Mount base unit on a flat surface. If the mounting surface is uneven, this may strain the printed circuit boards and cause malfunctions.

- (6) Avoid mounting the base unit in proximity to vibration sources such as large magnetic contractors and no-fuse circuit breakers; mount these on a separate panel or at a distance.
- (7) In order to avoid the effects of radiated noise and heat, provide the clearances indicated below between the PLC and devices that generate noise or heat (contactors and relays).

 - •Required clearance on the right and left of..... 50mm or more (1.97inch)



4.2 Fail-Safe Circuit Concept

When the PLC is powered ON and then OFF, improper outputs may be generated temporarily depending on the delay time and start-up time differences between the PLC power supply and the external power supply for the control target (especially, DC).

For example, if the external power supply for the control target is powered ON and then the PLC is powered ON, the DC output module may generate incorrect outputs temporarily upon the PLC power-ON. Therefore, it is required to build the circuit that energizes the PLC by priority.

The external power failure or PLC failure may lead to the system error. In order to eliminate the possibility of the system error and ensure fail-safe operation, build the following circuit outside the PLC: emergency circuit, protection circuit and interlock circuit, as they could cause machine damages and accidents due to the abovementioned failures.

An example of system design, which is based on fail-safe concept, is provided on the next page.

DANGER ●

Create a safety circuit outside the PLC to ensure the whole system will operate safely even if an external power failure or a PLC failure occurs.

Otherwise, incorrect output or malfunction may cause an accident.

- (1) For an emergency stop circuit, protection circuit and interlock circuit that is designed for incompatible actions such as forward/reverse rotation or for damage prevention such as the upper/lower limit setting in positioning, any of them must be created outside the PLC.
- (2) When the PLC detects the following error conditions, it stops the operation and turn off all the outputs.
 - The overcurrent protection device or overvoltage protection device of the power supply module is activated.
 - The PLC CPU detects an error such as a watchdog timer error by the self-diagnostics function.
 In the case of an error of a part such as an I/O control part that cannot be detected by the PLC CPU, all the outputs may turn on. In order to make all machines operate safely in such a case, set up a fail-safe circuit or a specific mechanism outside the PLC.
 Refer to "LOADING AND INSTALLATION" in this manual for example fail safe circuits.
- (3) Depending on the failure of the output module's relay or transistor, the output status may remain ON or OFF incorrectly. For output signals that may lead to a serious accident, create an external monitoring circuit.
- If load current more than the rating or overcurrent due to a short circuit in the load has flowed in the output module for a long time, it may cause a fire and smoke. Provide an external safety device such as a fuse.
- Design a circuit so that the external power will be supplied after power-up of the PLC.
 Activating the external power supply prior to the PLC may result in an accident due to incorrect output or malfunction.
- For the operation status of each station at a communication error in data link, refer to the respective data link manual.
 The communication error may result in an accident due to incorrect output or malfunction.

 DANGER
 When controlling a running PLC (data modification) by connecting a peripheral device to the CPU module or a PC to a special function module, create an interlock circuit on sequence programs so that the whole system functions safely all the time.

> Also, before performing any other controls (e.g. program modification, operating status change (status control)), read the manual carefully and ensure the safety.

> In these controls, especially the one from an external device to a PLC in a remote location, some PLC side problem may not be resolved immediately due to failure of data communications.

To prevent this, create an interlock circuit on sequence programs and establish corrective procedures for communication failure between the external device and the PLC CPU.

When setting up the system, do not allow any empty slot on the base unit.

If any slot is left empty, be sure to use a blank cover (AG60) or a dummy module (AG62) for it.

When using the extension base unit, A52B, A55B or A58B, attach the included dustproof cover to the module in slot 0. Otherwise, internal parts of the module may be flied in the short circuit test or when an overcurrent or overvoltage is accidentally applied to external I/O section.

⚠CAUTION •

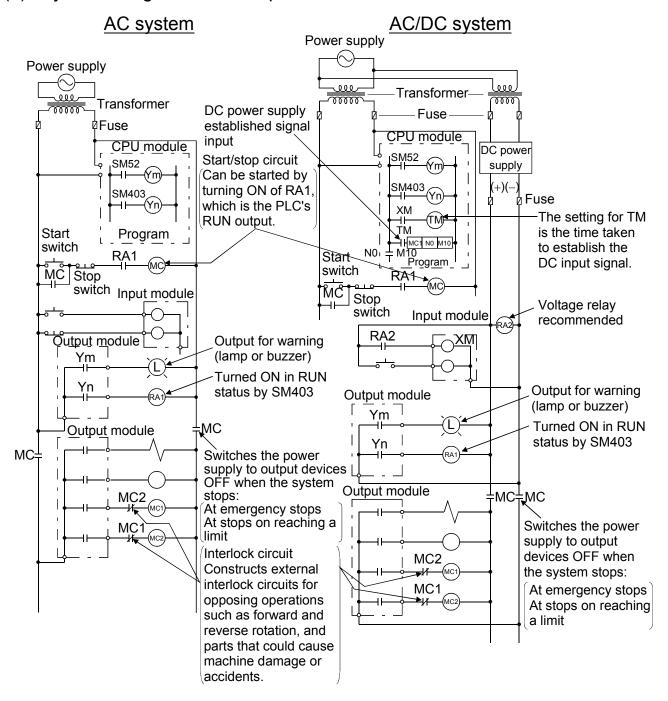
Do not install the control lines or communication cables together with the main circuit or power lines, or bring them close to each other.

Keep a distance of 100mm (3.94inch) or more between them.

Failure to do so may cause malfunctions due to noise.

- If having read register R outside the allowable range with the MOV instruction, the file register data will be FFFFH. Using this as it is may cause malfunctions. Pay attention not to use any out-of-range file register when designing sequence programs. For instruction details, refer to the programming manual.
- When an output module is used to control the lamp load, heater, solenoid valve, etc., a large current (ten times larger than the normal one) may flow at the time that the output status changes from OFF to ON. Take some preventive measures such as replacing the output module with the one of a suitable current rating.

(1) System design circuit example



The procedures used to switch on the power supply are indicated below.

AC system

- Switch the power supply ON.
- [2] Set the CPU module to RUN.
- [3] Switch the start switch ON.

[1]

[4] The output devices are driven in accordance with program when the magnetic contactor (MC) turns ON.

AC/DC system

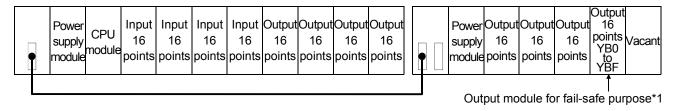
- [1] Switch the power supply ON.
- [2] Set the CPU module to RUN.
- [3] Switch RA2 ON when the DC power supply starts.
- [4] Switch the timer (TM) ON when the DC power supply reaches working voltage. (The set value for TM must be the time it takes for 100% establishment of the DC power after RA2 is switched ON. Make this set value 0.5 seconds.)
- [5] Switch the start switch ON.
- [6] The output devices are driven in accordance with the program when the magnetic contactor (MC) comes ON. (If a voltage relay is used at RA2, no timer (TM) is necessary in the program.)

(2) Fail-safe measures to cover the possibility of PLC failure Problems with a CPU module and memory can be detected by the self diagnostics function. However, problems with I/O control area may not be detected by the CPU module.

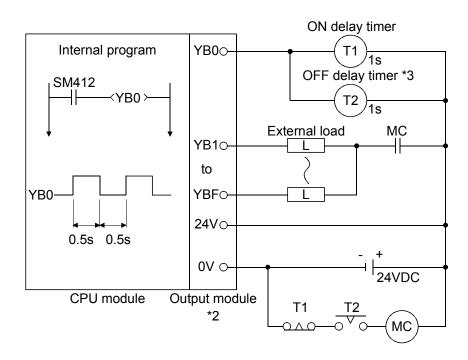
In such cases, all I/O points turn ON or OFF depending on the problem, and normal operation and safety cannot be maintained.

Though Mitsubishi PLCs are manufactured under strict quality control, they may fail or malfunction due to unspecified reasons. To prevent the whole system failure, machine breakdown, and accidents, build a fail-safe circuit outside the PLC.

Examples of a system and its fail-safe circuitry are described below: <System example>

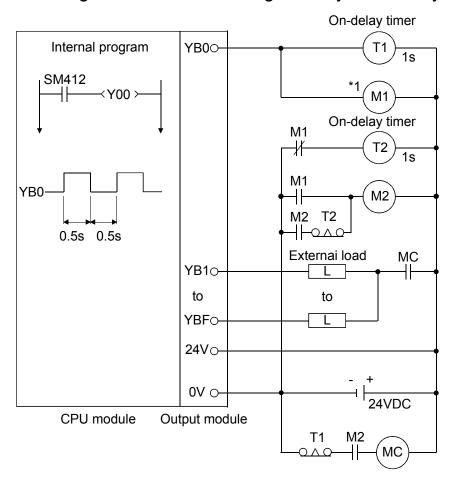


*1: The output module for fail-safe purpose should be mounted on the last slot of the system. (YB0 to YBF in the above system.)



- *2: Since YB0 turns ON and OFF alternatively at 0.5 second intervals, use a contactless output module (a transistor is used in the above example).
- *3: If an offdelay timer (especially miniature timer) is not available, construct the failsafe circuit using an ondelay timer shown on the next page.

When constructing a failsafe circuit using ondelay timers only



*1: Use a solid state relay for the M1 relay.

4.3 Power supply connection

4.3.1 Performance Specifications for Power Supply Modules

(1) Standard power supply module

Table 4.1 Power Supply Module Specifications

Item					Specification	ns		
item		A61P	A61PN	A62P	A63P	A65P	A66P	A67P
Base unit pos	sition		I		I/O module slot	Power supply module slot		
Input voltage			120 VAC 5 to 132 \	-15%	24VDC +30% -35%	100 to 120	VAC +10% -15% 32 VAC)	110 VDC (85 to 140
input voltage			240 VAC 70 to 264 '	-15 %	(15.6 to 31.2 VDC)	200 to 240	VAC +10 % -15 % 264 VAC)	VDC)
Input frequen	iCV	,	0/60 Hz ±	,		•	1z ±5 %	
Input voltage distortion fact			Within 5° er to Secti	%	_	Withi	in 5% Section 4.4)	
Max. input ap power	parent	160	VA	155 VA	65 W	110 VA	95 VA	65 W
Inrush curren	t	20 A	A, within 8	ms *4	100 A, within 1 ms	20 A, with	in 8 ms *4	20 A, within 8 ms
Rated output	5 VDC	8 A		5 A	8 A	2 A	_	8 A
current	24 VDC	_		0.8 A	—	1.5 A	1.2 A	—
*1 Overcurrent	5 VDC	8.8 A or higher		5.5 A or higher	8.5 A or higher	2.2 A or higher	_	8.5 A or higher
protection	24 VDC		_	1.2 A or higher	_	2.3 A or higher	1.7 A or higher	_
*2 Overvoltage	5 VDC	5.5 to	6.5 V	5.5 to 6.5 V	5.5 to 6.5 V	5.5 to 6.5 V		5.5 to 6.5 V
protection	24 VDC							
Efficiency					65 % or high	er		
Withstanding	voltage				en all AC externa n all DC external		•	
Noise durability		Noise voltage 1500 VP-P Noise width 1 \mu s, Noise frequency 25 to 60 Hz (noise simulator condition)		Noise voltage 500 VP-P Noise width 1 \(\mu \)s, Noise Noise width 1 \(\mu \)s,		00 V _{P-P} μs, to 60 Hz		
Insulation resi	istance	10	MΩ or hiç	gher, measu	red with a 500 V	DC insulation	n resistance	tester
Power indicat	or				Power LED dis	play		
Terminal scre	w size			M4 × 0.	.7 × 6		M3 × 0.5 × 6	M4 × 0.7 × 6

Table 4.1 Power Supply Module Specifications

ltom		Specifications							
Item	A61P	A61PN	A62P	A63P	A65P	A66P	A67P		
Applicable wire size				0.75 to 2	2 mm ²				
A - FII II- I						R1.25-3,	R1.25-4,		
Applicable solderless	I	R1.25-4, F	R2-4, RAV	1.25, RAV2	<u>-</u> 4	R2-3	R2-4		
terminal						RAV1.25-3,	RAV1.25-4,		
A 15 11 15 14 15						RAV2-3	RAV2-4		
Applicable tightening		78	3 to 118 N	·cm		39 to 59	78 to 118		
torque						N⋅cm	N⋅cm		
						250 (H) ×	250 (H) ×		
	250 () × 55 (W)	37.5 (W)×	55 (W)×					
External dimensions	250 (1) × 33 (VV)	121 (D)	121 (D)					
			(9.8×1.5	(9.8×2.1					
						×4.7)	×4.7)		
Weight	0.98 kg	0.75 kg	0.94 kg	0.8 kg	0.94 kg	0.75 kg	0.8 kg		
							Less than		
Allowable momentary		aa than 20		Less than	Less than		20ms		
power interruption time *3	Less than 20ms			1ms	20ms		(at 100		
							VDC)		

REMARK

The A66P module occupies 1 slot

(2) CE marked power supply module

Table 4.2 Power Supply Module Specifications

	Itam		Specific	cations		
	Item		A61PEU	A62PEU		
Base unit loading position			Power supply	y module slot		
Input voltage	9		100 to 120 / 200 to 240 VAC +10% -15%			
Input freque	ncy		50/60 H	łz ±5 %		
Input voltage	e distor	tion factor	Within 5% (Refe	er to Section 4.4)		
Max. input a	pparer	nt power	130 VA	155 VA		
Inrush curre	nt		20 A, with	in 8 ms *4		
Rated output	t	5 VDC	8 A	5 A		
current		24 VDC	_	0.8 A		
Overcurrent		5 VDC	8.8 A or higher	5.5 A or higher		
protection *	1	24 VDC		1.2 A or higher		
Overvoltage		5 VDC	5.5 to 6.5 V	_		
protection *	2	24 VDC	_	_		
Efficiency			65 % or higher			
Dielectric withstand voltage		is primary and FG	2830VAC rms/3 cycles (2000m (6562 ft.))			
Noise durabi	lity		Noise voltage IEC801-4; 2kV, 1500 VP-P			
			Noise width 1μ s, Noise frequency 25	-		
Insulation res	sistanc	е	10 M ^Ω or higher, measured with a 5	500 VDC insulation resistance tester		
Power indica	itor		Power LE	D display		
Terminal scr	ew size	9		0.7 × 6		
Applicable w			0.75 to	2 mm ²		
Applicable solderless terminal			RAV1.25-4, RAV2-4			
Applicable tightening torque			98 to 13	7 N·cm		
External dimensions			250 (H) × 55 (W)× 121 (D)	(9.8× 2.1× 4.7) mm (inch)		
Weight			0.8 kg	0.9 kg		
Allowable mo interruption t		ary power	Less that	an 20ms		

POINT

- *1: Overcurrent protection
 - (a) The overcurrent protection device shuts off the 5VDC and/or 24VDC circuit(s) and stops the system if the current exceeding the specified value flows in the circuit(s). As this results in voltage drop, the power supply module LED turns OFF or is dimly lit.
 - (b) After that, eliminate the causes of overcurrent, e.g., insufficient current capacity and short circuit, and then start the system. When the current has reached the normal value, the initial start up of the system will be performed.
- *2: Overvoltage protection

The overvoltage protection shuts off the 5VDC circuit and stops the system if the overvoltage of 5.5 to 6.5V is applied to the circuit. This results in the power supply module LED turning OFF. When restarting the system, power OFF and ON the input power supply, and the initial start up of the system will be performed. If the system is not booted and the LED remains off, this means that the power supply module has to be replaced.

- *3: Allowable momentary power failure period
 The PLC CPU allowable momentary power failure period varies
 with the power supply module used.
 In case of the A63P power supply module, the allowable
 momentary power failure period is defined as the time from when
 the primary side of the stabilized power supply for supplying 24VDC
 to the A63P is turned OFF until when the voltage (secondary side)
 has dropped from 24VDC to the specified value (15.6VDC) or less.
- *4: Inrush current

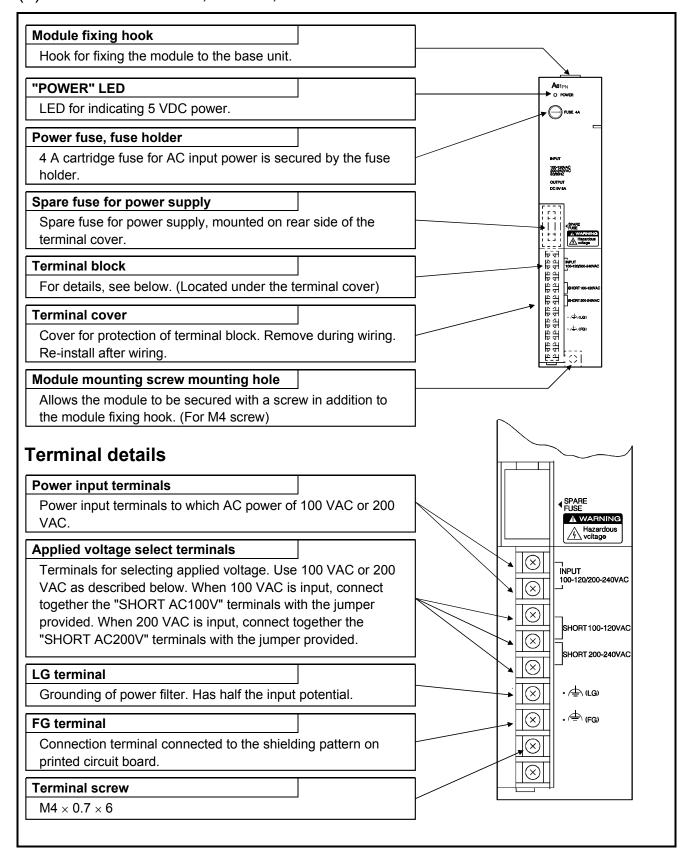
If the power supply module is re-powered ON right after powered OFF (within 5seconds), the inrush current exceeding the specified value (2ms or less) may be generated. Therefore, make sure to re-power ON the module 5seconds after power off.

When selecting a fuse or breaker for external circuit, consider the above point as well as meltdown and detection characteristics.

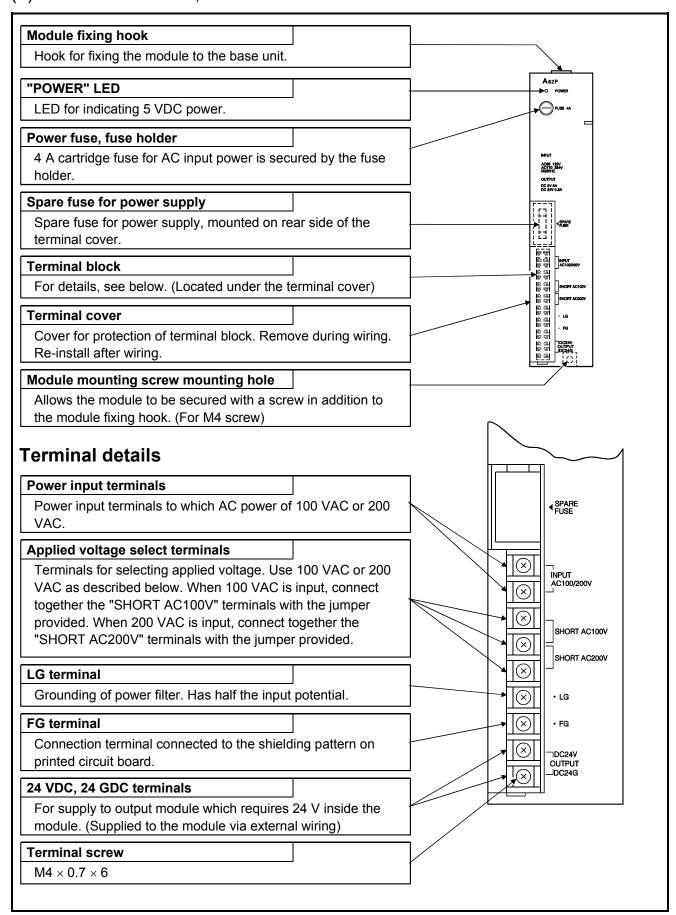
4.3.2 Part names and settings of Power Supply Module

The parts of the power supply modules are explained belows.

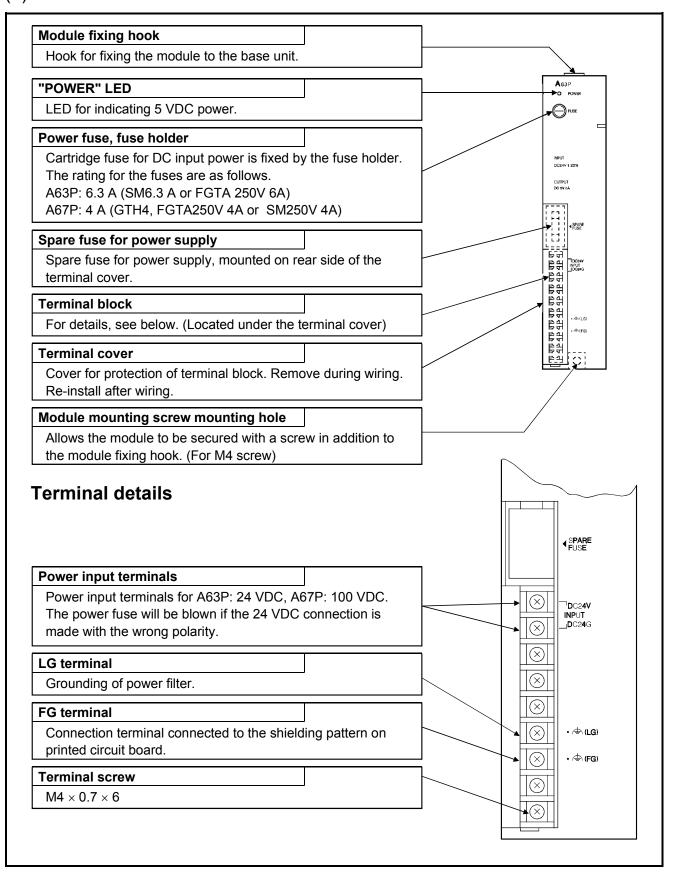
(1) Parts of the A61P, A61PN, A61PEU modules



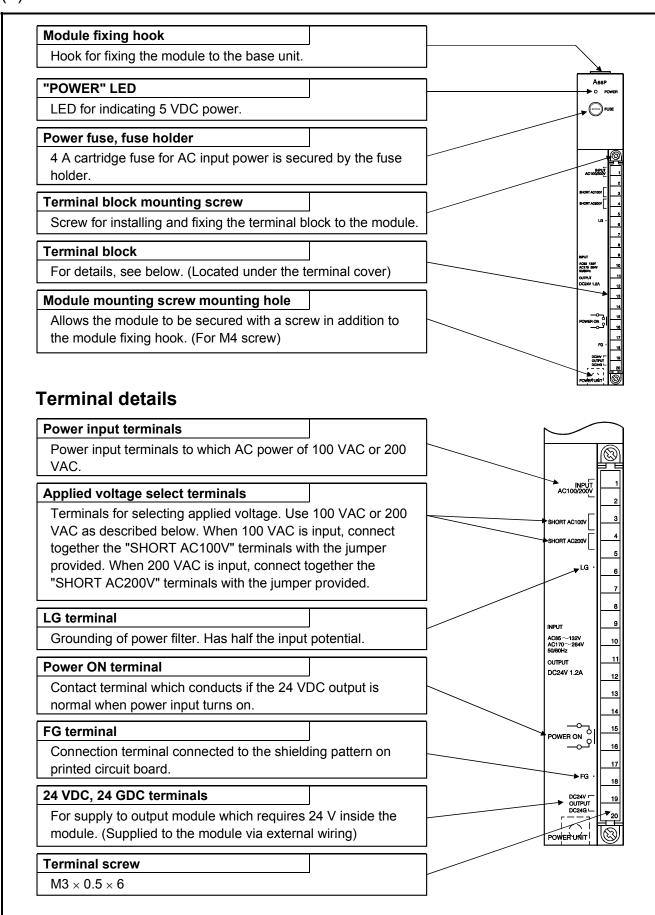
(2) Parts of the A62P, A62PEU and A65P modules



(3) Parts of the A63P and A67P modules

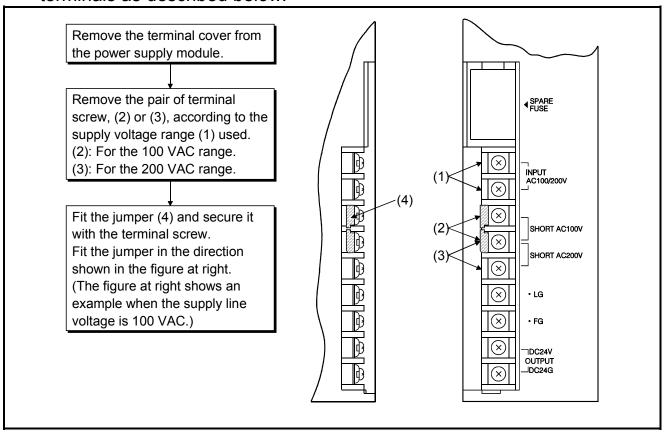


(4) Parts of the A66P module



(5) Settings

For A61P(EU), A61PN, A62P(EU), A65P or A66P, the input voltage range, 100V or 200V, must be specified by placing a jumper (supplied) across two terminals as described below:



POINT

If the setting differs from the supply line voltage, the following occurs: do not mis-set.

	Supply Lir	ne Voltage		
	100VAC	200VAC		
Setting to 100VAC (jumper fitted as indicated at (2))	_	The power supply module is damaged. (The CPU module is not damaged.)		
Setting to 200VAC (jumper fitted as indicated at (3))	No error occurs in the module. However, the CPU module does not operate.			
No setting (jumper not fitted)	No error occurs in the module. However, the CPU module does not operate.			

4.3.3 Wiring instructions

Instructions for wiring the power supply cable and I/O cable.

the product.

DANGER ■

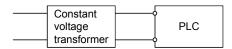
- Be sure to shut off all phases of the external power supply used by the system before wiring. Failure to do so may result in an electric shock or damage of
- Before energizing and operating the system after wiring, be sure to attach the terminal cover supplied with the product. Failure to do so may cause an electric shock.

- **!** CAUTION Always ground the FG and LG terminals to the protective ground conductor.
 - Failure to do so may cause an electric shock or malfunctions.
 - Wire the module correctly after confirming the rated voltage and terminal layout.
 - Connecting a power supply of a different voltage rating or incorrect wiring may cause a fire or failure.
 - Do not connect multiple power supply modules to one module in parallel. The power supply modules may be heated, resulting in a fire or failure.
 - Press, crimp or properly solder the connector for external connection with the specified tool. Incomplete connection may cause a short circuit, fire or malfunctions.
 - Tighten terminal screws within the specified torque range. If the screw is too loose, it may cause a short circuit, fire or malfunctions.
 - If too tight, it may damage the screw and/or the module, resulting in a short circuit or malfunctions.
 - Carefully prevent foreign matter such as dust or wire chips from entering the module.
 - Failure to do so may cause a fire, failure or malfunctions.
 - Install our PLC in a control panel for use. Wire the main power supply to the power supply module installed in a control panel through a distribution terminal block.

Furthermore, the wiring and replacement of a power supply module have to be performed by a maintenance worker who acquainted with shock protection.

(For the wiring methods, refer to Q2ACPU(S1)/ Q3ACPU /Q4ACPU User's Manual)

- (1) Power Supply Connection
 - (a) When voltage fluctuations are larger than the specified value, connect a constant-voltage transformer.



(b) Use a power supply which generates minimal noise between wires and between the PLC and ground. If excessive noise is generated, connect an insulating transformer.

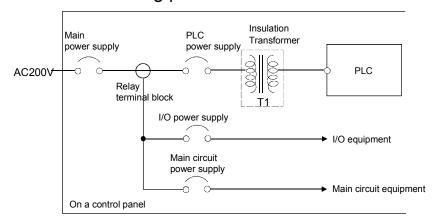


(c) When a power transformer or insulating transformer is employed to reduce the voltage from 200 VAC to 100 VAC, use one with a capacity greater than those indicated in the following table.

Power Supply Module	Transformer Capacity
A61P, A61PN	160VA × n
A62P	155VA $ imes$ n
A65P	110VA × n
A66P	95VA $ imes$ n

n: Stands for the number of power supply modules.

- (d) Provide separate wiring systems for the PLC power, I/O devices, and operating devices as shown below. If the wiring is influenced by excessive noise, connect an isolation transformer.
- (e) Taking rated current or inrush current into consideration when wiring the power supply, be sure to connect a breaker or an external fuse that have proper blown and detection.
 - When using a single PLC, a 10A breaker or an external fuse are recommended for wiring protection.



REMARK

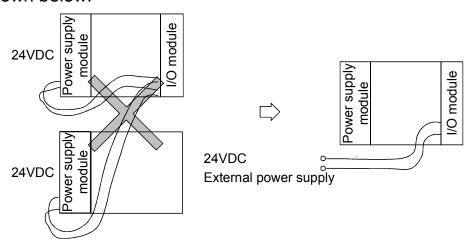
As safety measures, install a switch for use with "online I/O module change" only to each of the corresponding modules and equipment.

(f) Note on using the 24 VDC output of the A62P, A65P and A66P power supply module.

CAUTION •

Do not connect multiple power supply modules to one module in parallel. The power supply modules may be heated, resulting in a fire or failure.

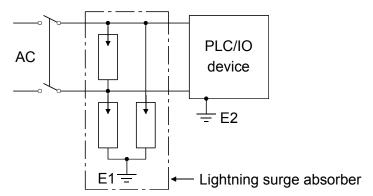
If the 24 VDC output capacity is insufficient for one power supply module, supply 24 VDC from the external 24 VDC power supply as shown below:



(g) 100VAC, 200VAC, and 24VDC wires should be twisted as tightly as possible, and connect the modules at the shortest distance between them.

To minimize voltage drop, use thick wires (MAX. 2mm²) where possible.

- (h) Do not bind 100VAC and 24VDC wires together with main circuit (high tension and large current) wires or I/O signal lines (including common line) nor place them near each other. Provide 100mm (3.94 inch) clearance between the wires if possible.
- (i) As a measure against surges caused by lightning, insert a lightning surge absorber as shown below.



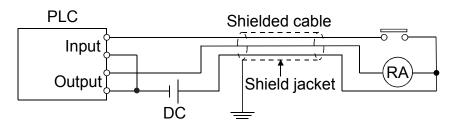
POINT

- (1) Provide separate grounding for the lightning surge absorber (E1) and the PLC (E2).
- (2) Select a lightning surge absorber whose maximum allowable circuit voltage is higher than the circuit voltage at the maximum power supply voltage.

(2) Wiring to I/O device

- (a) The solderless terminal with insulation sleeve is inapplicable to a terminal block.
 - It is advisable to cover the wire connection part of a terminal with a mark tube or insulation tube.
- (b) Install wiring to a terminal block using the cable of core diameter 0.3 to 0.75mm², and outside diameter 2.8mm or less.
- (c) Run the I/O line and output line away from each other.
- (d) When the main circuit line and power line cannot be separated, use a shielding cable and ground it on the PLC side.

However, ground it on the opposite side in some cases.

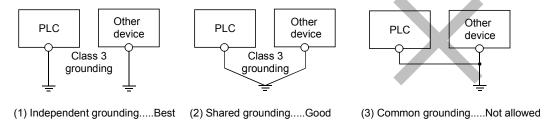


- (e) When cables are run through pipes, securely ground the pipes.
- (f) Run the 24VDC input line away from the 100VAC and 200 VAC lines.
- (g) The cabling of 200m (656.2ft.) or longer distance may produce leakage current depending on the capacity between lines and result in an accident.
- (h) As a countermeasure against the power surge due to lightning, separate the AC wiring and DC wiring and connect a surge absorber for lightning as shown in (i) of item (1).

(3) Grounding

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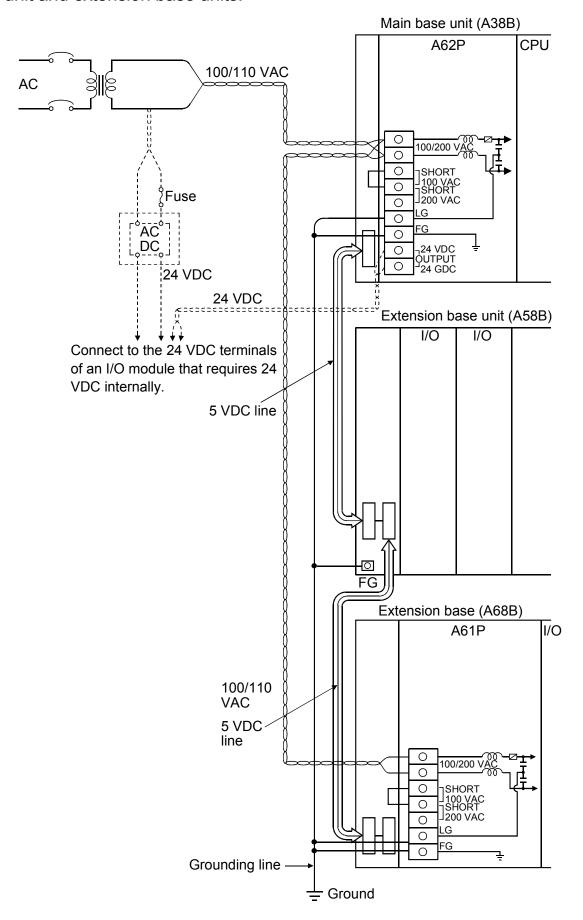
- (a) Carry out the independent grounding if possible. (Grounding resistance 100Ω or less.)
- (b) If the independent grounding is impossible, carry out the shared grounding (2) as shown below.



- (c) Use the cable of 2mm² or more for grounding. Set the grounding point closer to the PLC to make the grounding cable short as possible.
- (d) If a malfunction occurs due to earthling, separate either LG or FG of the base module, the device combination, or all the connection from the earthling.

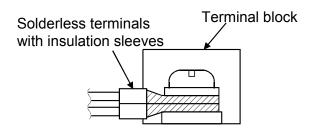
4.3.4 Wiring to module terminals

The following is an example of wiring of power supply and grounding wires to main base unit and extension base units.



POINT

(1) Use the thickest possible (max. 2 mm² (14 AWG)) wires for the 100/200 VAC and 24 VDC power cables. Be sure to twist these wires starting at the connection terminals. For wiring a terminal block, be sure to use a solderless terminal. To prevent short-circuit due to loosening screws, use the solderless terminals with insulation sleeves of 0.8 mm (0.03 inch) or less thick. The number of the solderless terminals to be connected for one terminal block are limited to 2.



(2) Be sure to ground the LG and FG terminals. Failure to do so may cause the PLC to be susceptible to noise. Note that LG terminals include the potential as half as that of input voltage; you might get an electric shock when you touch them.

4.4 Precaution when Connecting the Uninterruptive Power Supply (UPS)

Be sure of the following items when connecting the PLC system to the uninterruptive power supply (abbreviated as UPS hereafter):

As for UPS, use the online power system or online interactive system with a voltage distortion rate of 5% or less.

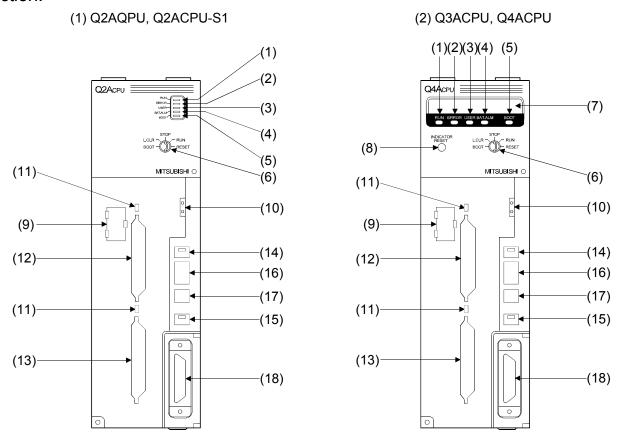
For the UPS of the commercial online power system, use Mitsubishi Electric's F Series UPS (serial number P or later) (Ex.: FW-F10-0.3K/0.5K).

Do not use any UPS of the commercial online power system other than the F series mentioned above.

4.5 Part Names and Settings

4.5.1 Part names and settings

The programmable controller nomenclature and settings are explained in this section.



Appearance with front cover open

No.	Name	Function						
(1)	RUN LED	Indicates the C Lamp ON Lamp OFF Lamp flashing	PU module operating Status. :When RUN/STOP key switch is set to RUN or STEP-RUN, and operation is in progress. :When RUN/STOP key switch is set to STOP, PAUSE or STEP-RUN and operation is stopped. Or, when an error that stops operation has been detected. :When a program is written during STOP and the RUN/STOP key switch is moved from "STOP" to "RUN". The CPU module is not in the RUN status. To put the CPU module in the RUN status, move the RUN/STOP key switch from "RUN" to "STOP" to "RUN" again. Alternatively, perform reset operation with the RUN/STOP key switch. (The Q3ACPU or Q4ACPU shows the "PRG. CHECK!!" message on the display.)					
(2)	ERROR LED	Lamp ON Lamp OFF Lamp flashing	:When a self diagnostics error (excluding battery error) which does not stop operation has been detected. (When a "continue operation at error detection" parameter setting has been designated.) :Normal :When an error that stops operation has been detected.					

No.	Name		Function				
(3)	USER LED	annunciator I (With Q3ACF the annuncia _amp OFF: Normal _amp flashing: Flashing whe (With Q3ACF	been detected by the CHK instruction, or an has come ON. PU or Q4ACPU, a message or the comment for tor is displayed on the LED indicator.) In latch clear is performed. PU or Q4ACPU, the message "L. CLR RDY" is the LED indicator.)				
(4)	BAT.ALARM LED	_amp ON :When a batte	ery error is activated by a low voltage condition nodule and memory card battery.				
(5)	BOOT LED	-	peration is completed. peration is not being executed.				
(6)	RUN/STOP key switch	CLR :Sets all data "OFF" or "0". registrations.	ogram operation EXECUTE/STOP. in the latch area (designated by parameter) to Also dears sampling trace and status latch ardware reset for operation error, and to ation, etc.				
(7)	LED display (Q3A and Q4ACPU only)	16-character display Display content includes comments for self diagnostics errors, comments to LED display instructions, clock data for SET SM212, and annunciator F-No comments for SET F, etc.					
(8)	Display RESET switch (Q3A and Q4ACPU only)	Clears the LED display content, displays the next data (when next data exists).					
(9)	Battery (A6BAT)	Battery for internal memory ar	nd power failure backup.				
(10)	Battery connector pin	•	tion. (To prevent wasted battery power disconnected from the connector when shipped				
(11)	Memory card EJECT button	Ejects the memory card from	the CPU module.				
	Memory card "A" installation connector Memory card "B"	Connectors for installing mem	ory cards in the CPU module.				
(13)	installation connector						
(14)	Memory card "A" in/out (with built in LED)		s whether or not the memory card can be wer is ON. Factory set to OFF.				
(15)	Memory card "B" in/out switch (with built in LED)	OFF :Insertion/ejection permitted (LED is OFF)					

No.	Name		Function					
(16)	Ejects the memory card from the CPU →ON 1 2	factory se SW1 : ON : OFF :	et to OFF. Boot settir Boot oper Boot oper SW4 : Para whe	ng. Desigration ation is no ameter are ameter are Memory	nates the root performed a. These eters are so card A	nemory used. switchesstored. Memory	sed for op designate / card B	the memory
	3 4 5	SW2 SW3 SW4	OFF OFF	ON OFF OFF	OFF ON OFF	ON ON OFF	OFF OFF ON	*SW2 to 4 are valid if SW1 is OFF.
		SW5 : ON : OFF :	System properations System properations	rotect. Pre s. rotect ON rotect OFF	vents all (CPU modu	ule writing	and control
		factory se	et to OFF.	•			eration. A	Il switches are
(17)	System setting switch 2 ON 1 2	SW1: For future expansion. Not used at present SW2 : Peripheral protocol. Designates the types of peripheral devices connected to the CPU module peripheral interface. (Set to ON if another ACPU station is to be accessed from a peripheral device. The ON or OFF setting becomes valid immediately upon switching.) ON : ACPU peripheral device 1: For future expansion. Not used at present OFF : QnACPU peripheral device						
(18)	RS-422 connector		or for conn	· · ·		al devices	3.	

4.5.2 Switch settings and corresponding LED displays

(1) Program writing when CPU module is stopped.

To execute program writing when the CPU module is stopped, follow the key switch setting procedure shown below.

(a) RUN/STOP key switch :STOP RUN LED :OFF

Q3ACPU, Q4ACPU display :OFF

......CPU module STOP status → program write

(b) RUN/STOP key switch :RESET RUN LED :OFF

Q3ACPU, Q4ACPU display :"PRG.CHECK!" message is displayed

......CPU module STOP status

(c) RUN/STOP key switch :STOP → RUN

RUN LED :ON Q3ACPU, Q4ACPU display :OFF

......CPU module STOP status

POINT

- After writing a program (except for online program write), perform reset operation, and then place the CPU module in the RUN status.
- When remote STOP is switched to RUN, the CPU module is not put in the "PROG CHECK" status but is placed in the RUN status.
- (2) Latch CLEAR operation

To execute a "Latch CLEAR", follow the key switch setting procedure shown below.

- Turn the RUN/STOP key switch of the CPU module from the "STOP" position to the "L. CLR" position several times to flicker the "USER LED" on the CPU module front.
 - Normally, the LED flickers when the switch is turned several times (three or four times).
 - When the "USER LED" flickers, it indicates that latch clear is ready.
- After the "USER LED" has flickered, turning the RUN/STOP key switch from the "STOP" position to the "L. CLR" position again executes latch clear and lights up the "USER LED".
 - If the "USER LED" comes on for two seconds and then goes off, it indicates that latch clear is completed normally.
- 3) To cancel latch clear midway, turn the RUN/STOP key switch to the "RUN" position to place the CPU module in the RUN state, or turn it to the "RESET" position to make a reset.

POINT

- The devices where the "Latch CLEAR" occurs can be designated by the "Latch CLEAR" enabled/disabled settings for each device made in device setting in the parameter mode.
- In addition to the RUN/STOP key switch method, a remote "Latch CLEAR" can also be executed from a peripheral device. (Refer to the Q2A (S1)/Q3A/Q4ACPU User's Manual).
- (3) Removing a memory card while PLC power is ON To remove the memory card while the PLC power is ON, set the "memory card in/out" switch as shown below. Removing a memory card while power is ON:

POINT

- The built-in LED at the "memory card in/out" switch may not go OFF if a CPU module system function (sampling trace, status latch, etc.) is in progress, or if the memory card is being used by the program. In such cases, stop the system function or the program, then remove the memory card after checking that the switch's built-in LED has turned OFF.
- Do not turn the "memory card in/out" switch ON after removing the memory card. An error will occur if the switch is turned ON at this time.
- When there are parameter-set file registers, local devices or failure history, the memory card cannot be the removed.
 If the "memory card in/out" switch is turned OFF, the in/out switch built-in LED does not go off.

For the file registers, the memory card can be removed when they are set to be unused with the QDRSET(P) instruction.

- (4) Inserting a memory card while PLC power is ON

 To insert the memory card while the PLC power is ON, set the "memory card in/out" switch as shown below.
 - (a) Insert the memory card.
 - (b) Turn the "memory card in/out" switch ON (built-in LED ON)
 Memory card insertion/ejection prohibited

POINT

- After inserting the memory card, turn the "memory card in/out" switch ON. The memory card cannot be used until the switch is turned ON.
- Since mount processing is performed again after the memory card is inserted, note that the scan time of one scan when mount processing is performed increases by a maximum of 10ms.

5. I/O MODULE SPECIFICATIONS AND CONNECTIONS

This section presents the specifications and wiring drawings for each of the A series I/O modules.

5.1 Input Modules

5.1.1 Input module specifications

		Number			Operatin	g Voltage	Maximum	
Model	Input Type	of Points/ Module	Rated Input Voltage	Input Current	ON Voltage	OFF Voltage	Simultaneous ON Input Point (Percentage Simultaneous ON)	
AX10		16 points		10mA	80VAC		100%	
AX11		32	100V to 120VAC	TOTIA	or higher	40VAC or lower	600/	
AX11EU	AQ:(points		12mA	79VAC or higher	-	60%	
AX20	AC input	16 points		10mA			100%	
AX21		32	200V to 240VAC	TOTAL	160VAC or higher	70VAC or lower	60%	
AX21EU		points		12mA			0076	
AX40		16 points					100%	
AX41	DC input	32		4/10mA	9.5VDC or higher	6VDC or lower	60%	
AX41-S1	(sink type)	points	12/24 VDC				00%	
AX42 *1		64		3/7mA			60% *3	
AX42-S1 *1	DC input	points					0070 3	
AX50	DC input (sink type)		101/17.0		34VDC	10VDC or lower		
AX50-S1	DC input (sink/source type)		48VDC	4mA	or higher			
AX60	DC input (sink type)		100/110/	04	80VDC	20VDC		
AX60-S1	DC input (sink/source type)		125VDC	2mA	or higher	or lower		
		16 points	5VDC (SW ON)	3.5mA (TYP) 5.5mA (MAX)	3.5VDC or higher	1.1VDC or lower	100%	
AX70	Sensor input (sink/source type)	2:	12VDC (SW OFF)	2mA (TYP) 3mA (MAX)	5VDC	2VDC or lower		
			24VDC (SW OFF)		or higher			

	Input Resp	onse Time					
	OFF to ON	ON to OFF	External Connections	Common Terminal Arrangement	Internal Current Consumption	Number of Occupied I/O Points	
			20 terminal block connector	16 points/ common	0.055A	16 points	
			38 terminal block	32 points/	0.11A	32 points	
	15ms or less	25ms or less	connector	common	0.15A	oz pomio	
	TOTAL OF ICOS	20110 01 1000	20 terminal block connector	16 points/ common	0.055A	16 points	
			38 terminal block	32 points/	0.11A	32 points	
			connector	common	0.15A		
	10ms or less	10ms or less	20 terminal block connector	8 points/	0.055A	16 points	
			38 terminal block	common	0.11A	32 points	
	0.1ms or less	0.2ms or less	connector	32 points/ common			
	10ms or less	10ms or less	40-pin connector	32 points/	0.12A	64 point	
	0.5ms or less	0.5ms or less	× 2	common		32 points	
	10ms or less	10ms or less					
	10ms or less	20ms or less					
	1.5ms or less	3ms or less	20 terminal block connector	8 points/ common	0.055A	16 points	

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(From front page)

		Number	Detect		Operating	g Voltage	Maximum		
Model	Input Type	of Points/ Module	Rated Input Voltage	Input Current	ON Voltage	OFF Voltage	Simultaneous ON Input Point (Percentage Simultaneous ON)		
			5VDC (SW ON)	3.5mA (TYP) 5.5mA (MAX)	3.5VDC or higher	1.1VDC or lower			
AX71	Sensor input (sink/source type)	32 points	12VDC (SW OFF)	2mA (TYP) 3mA (MAX)	5VDC	2VDC			
			24VDC (SW OFF)	4.5mA (TYP) 6mA (MAX)	or higher	or lower	100%		
AX80									
AX80E	DC input (source type)	16 points	12/24 VDC			9.5VDC 6VDC or lower			
AX81	-								
AX81-S1	DC input	32		2.5/5mA	5.6VDC or higher	2.4VDC or lower			
AX81-S2	DC input (source type)	points	48/60 VDC	3/4mA	31VDC or higher	10VDC or lower			
AX81-S3	DC input		12/24 VDC	4/10mA	9.5VDC or higher	6VDC or lower			
AX81B	DC input (sink/source type)	32 points	24VDC	7mA	At normal 21VDC or higher When disc detected 1VDC or higher	6VDC or lower	60%		
AX82 *1	DC Input (source type)	64 points	12/24 VDC	3/7mA	9.5VDC or higher	6VDC or lower			
AX31	AC/DC input	32 points	12/24 VAC 12/24 VDC	8.5/4mA	7VAC/ VDC or higher	2.5VAC /VDC or lower	100%		

Input Resp	onse Time					
OFF to ON	ON to OFF	External Connections	Common Terminal Arrangement	Internal Current Consumption	Number of Occupied I/O Points	
1.5ms or less	3ms or less	38 terminal block connector		0.11A	32 points	
10ms or less	10ms or less	20 terminal block connector	8points/ common			
[TYP] 5.5ms 6.0ms [High-speed mode]			COMMON	0.055A	16 points	
0.5ms or less	1.0ms or less					
10ms or less	10ms or less	00 (0.11A 0.105A	32 points	
20ms or less	20ms or less	38 terminal block connector				
0.1ms or less	0.2ms or less			0.11A		
10ms or less	10ms or less	38 terminal block connector	8 points/ common	0.125A	64 points	
10ms or less	10ms or less	37-pin D subconnector × 2		0.12A	64 points	
25ms or less	20000 001000	38 terminal block	32 points/ common	0.11A 32	20 nainta	
20ms or less	20ms or less	connector			32 points	

The following specifications apply to all modules:

Isolation method : Photocoupler

Input indication : LEDs

*1 : The ON/OFF status of the first or latter half is indicated by the LEDs in accordance with the setting of the selector switch on the front panel of the module:

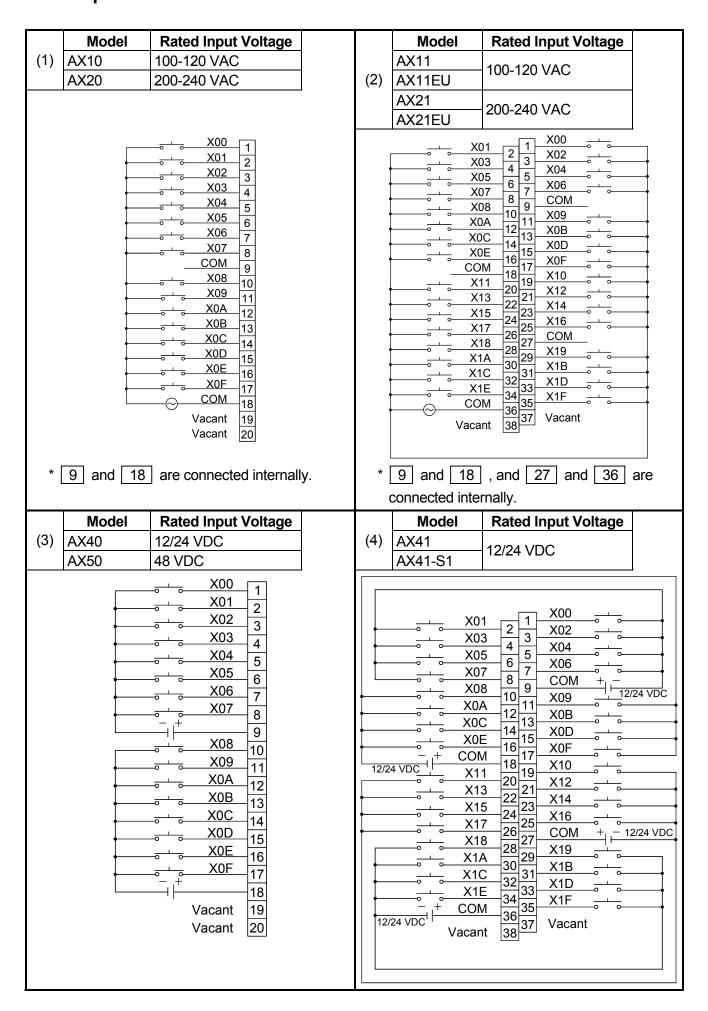
FH setting: First half (X00 to X1F), LH setting: Latter half (X20 to X3F)

*2 : It is possible to select high speed or low speed for the upper eight points only using the DIP switch:

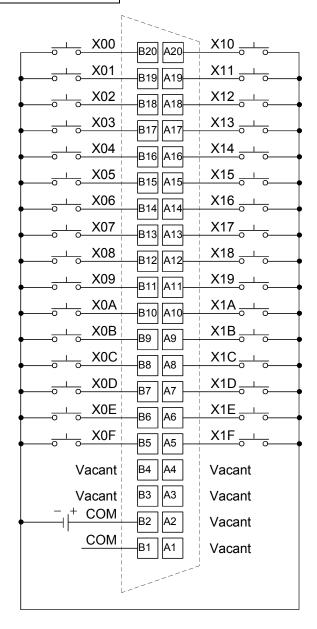
HIGH setting: high-speed, LOW setting: low-speed

*3: The number of simultaneous input points is 40% (13 inputs/common) simultaneously ON when the unit is used adjacent to the power supply module.

5.1.2 Input module connections



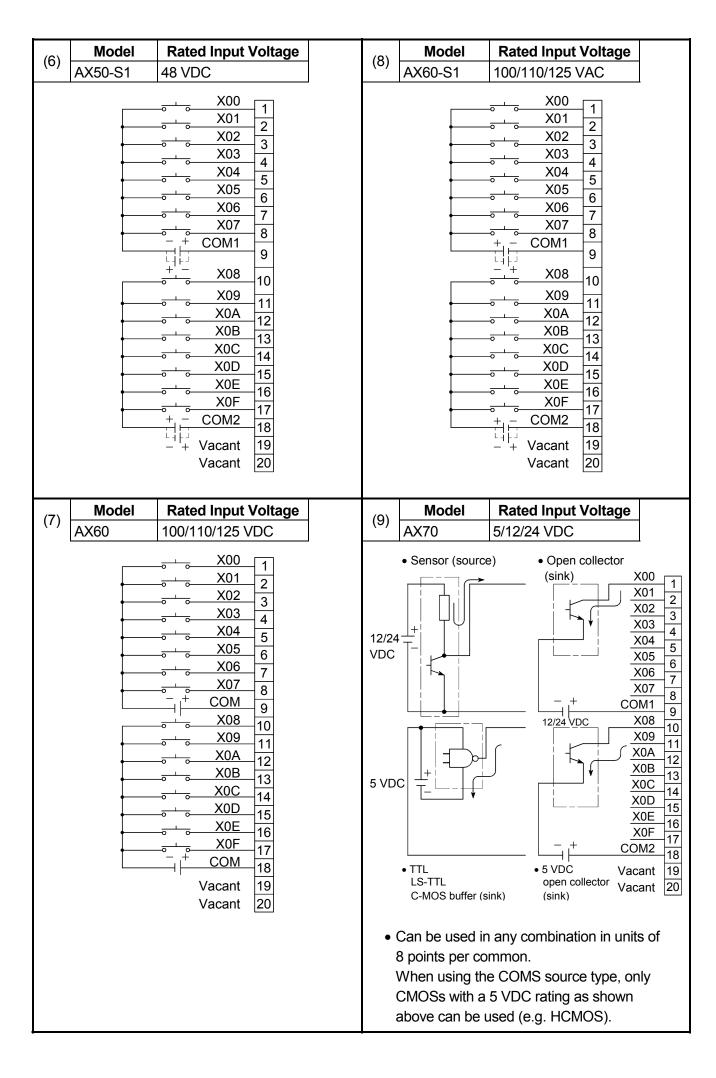
(5)	Model	Rated Input Voltage	
	AX42	12/24 VDC	
	AX42-S1		

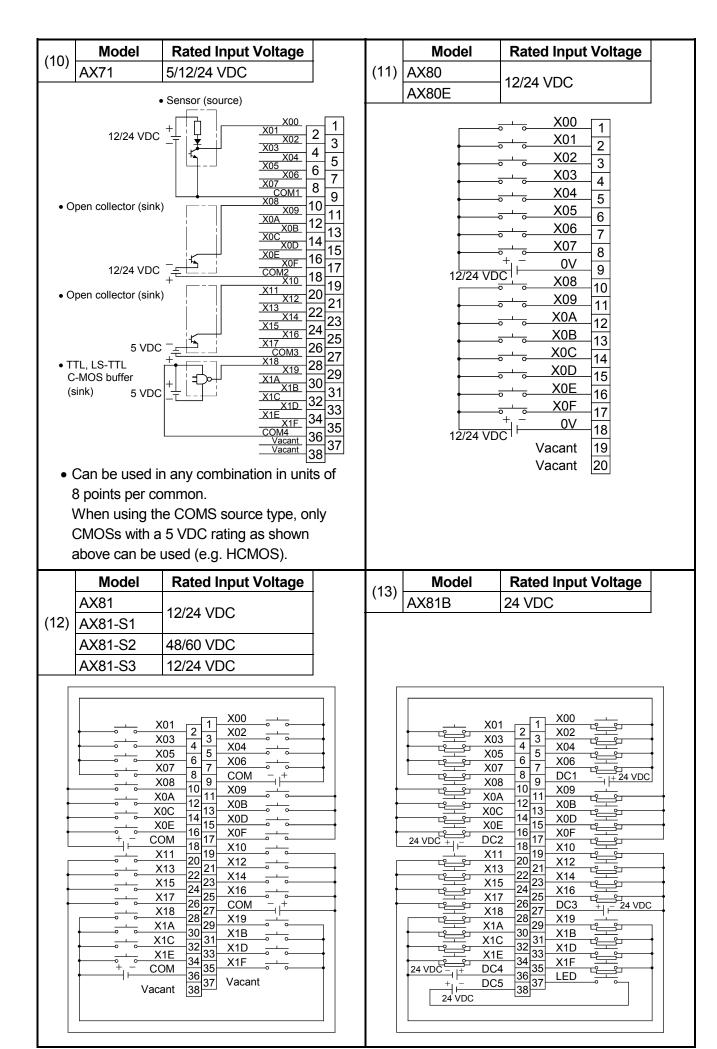


* The figure above indicates F (the first half 32 points).

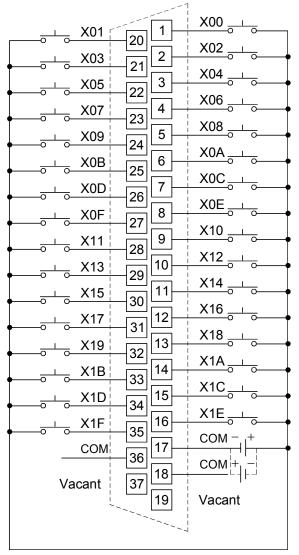
The connections for L (the latter half 32 points) are the same as for F (regard X00 to X1F as X20 to X3F).

B1 and B2 are connected internally.



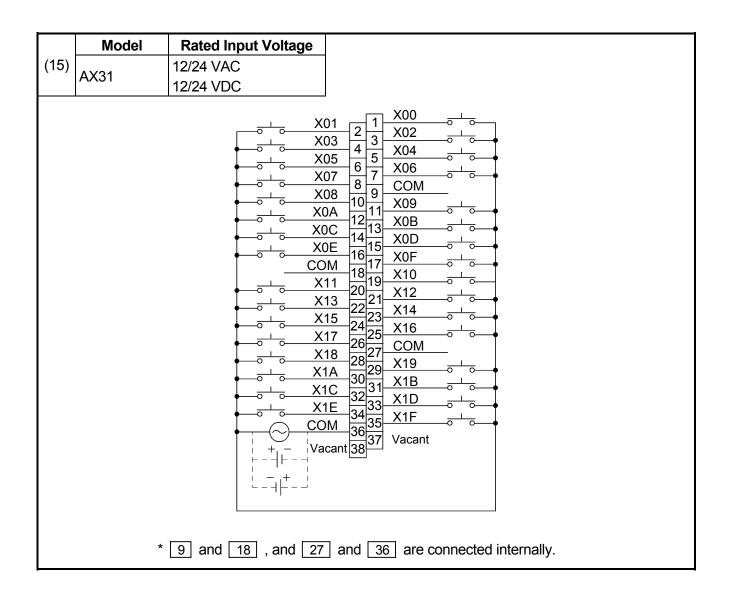


(14) Model Rated Input Voltage
AX82 12/24 VDC



- * The figure above indicates F (the first half 35 points).

 The connections for L (the latter half 32 points) are the same as for F (regard X00 to X1F as X20 to X3F).
 - 17, 18, and 36 are connected internally.



5.2 Output Modules

5.2.1 Output module specifications

Model	Output Type	No. of Points/	Rated Load	Max. Loa	d Current	_	Response me
		Module	Voltage	Per Point	Per Common	OFF to ON	ON to OFF
AY10	Contact output				8A		
AY10A	Contact output (All points independent)	-	240VAC 24VDC		16A/all points		
AY11	Contact output	16 points	l		8A		
AY11A	Contact output		0.0.00	- -	16A/all		
AY11AEU	(All points independent)		24VDC 24VAC	0.4	points	10ms or	12ms or
AY11E	. ,		240VAC 24VAC	2A	8A	less	less
AY11EEU			24VDC 24VAC		0,1		
AY13	Contact output		240VAC 240VAC 24VAC				
AY13EEU	Contact output	32 points	24VDC 24VAC		5A		
AY13E			240VAC 24VAC				
AY15EU		24 points	24VDC 240VAC		8A		
AY20EU				0.6A	1.9A		
AY22	Triac output	16 points	100 to 200 VAC	2A	3.3A	1ms or less	0.5Hz + 1ms or
AY23		32 points		0.6A	2.4A *4 (1.05A)		less
AY40	Transistor output (sink type)			0.1A	0.8A		
AY40A	Transistor output (all points independent sink type)	16 points	12/24VDC	0.3A	_	2ms or less	2ms or less (resistive load)
AY40P	Transistor output (sink type)			0.1A	0.8A		

External Connections	Common Terminal Arrangement	Surge Suppression	Fuse Rating	Error Display	External Power Supply (TYP 24VDC) Current	Internal Current Consumption	Number of Occupied I/O Points
20 terminal block connector 38 terminal block connector	8 points/ common No common (all points independent)	None	None				
20 terminal block connector 38 terminal block connector	8 points/ common No common (all points independent)	Varistor	None	Nana	0.15A	0.115A	16 points
20 terminal block connector			8A	None			
38 terminal	8 points/ common	None	None		0.29A	0.23A	32 points
block		None	8A				oz pointo
connector			None		0.22A	0.15A	
	4 points/ common	CR absorber	3.2A	5 : 1		0.40A	
20 terminal block connector		CR absorber varistor	7A *6	Display *10	_	0.305A	16 points
38 terminal block connector	8 points/ common	Absorber	3.2A *6			0.59A	32 points
20 terminal block connector		Clamp diode			0.008A	0.115A	
38 terminal block connector	No common (all points independent)	Surge absorbing diode	None	None	_	0.19A	16 points
20 terminal block connector	8 points/ common	Cramp diode			0.015A	0.115A	

Model	Output Type	No. of Points/	Rated Load	Max. Loa	d Current	_	desponse me
		Module	Voltage	Per Point	Per Common	OFF to	ON to OFF
AY41					1.6A		
AY41P		32 points			1A	2ms or	2ms or less
AY42 *1			12/24VDC	0.1A		less	(resistive load)
AY42-S1					2A *4 (1.6A)	0.1ms or less	0.3ms or less (resistive load)
AY42-S2		64 points	5/12/24 VDC				
AY42-S3 *1	Transistor output (sink type)			0.1A *5	2A		
AY42-S4 *1	(ev. sype)			0.1A	1.92A		2ms or less (resistive load)
AY50		16 points	12/24VDC	0.5A	2A	2ms or less	
AY51		32 points			2A *4 (3.3A)	1033	
AY51-S1				0.3A	2A		
AY60				2A	5A		
AY60E	Transistor output		24VDC (12/48V) *2	12/24 VDC 2A 48VDC 0.8A	3A		
AY60EP	(source type)	16 points	12/24VDC	12VDC 2A	9.6A	0.5ms or	1.5ms or
				24VDC 0.8A	3.8A	less	less
AY60S	Transistor output (sink type)		24/48VDC (12V) *3	2A	6.4A	1ms or less	3ms or less (resistive load)
AY70	Transistor output	16 points	5/10\/DC	0.016A	0.128A	1ms or	1ms or
AY71	(for TTL. COMOS) (sink type)	32 points	- 5/12VDC	0.016A	0.256A	less	less

External Connections	Common Terminal Arrangement	Surge Suppression	Fuse Rating	Error Display	External Power Supply (TYP 24VDC) Current	Internal Current Consumption	Number of Occupied I/O Points
38 terminal block connector	16 points/ common				0.02A 0.03A	0.23A	32 points
			None	None		0.29A	
40-pin	32 points/	Cramp diode	TTOTIC		0.04A	0.34A	
connector × 2	common					0.29A	64 points
			1.6A *7	Display *11		0.29A	
		Photo coupler Built-in Zener diode	None	None	_	0.5A	
20 terminal block connector	8 points/ common	Varistor	2A *6	Display *10	0.065A	0.115A	16 points
38 terminal	16 points/		None	None	0.05A	0.023A	
block connector	16 points/ common	Transistor Built-in Zener diode	1A *8	Display *10	0.1A	0.31A	32 points
		Varistor	3.2A *9		0.065A		
		Surge absorbing	5A *9	Display	0.065A	0.115A	
20 terminal block connector	8 points/ common	diode	None		0.11A		16 points
		Varistor	5A *9	None	0.003A	0.075A	
		None	None		*12 0.055A	0.1A	16 points
38 terminal block connector	16 points/ common	HOHO	NOILC		*12 0.1A	0.2A	32 points

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(From front page)

Model	Output Type	No. of Points/	Rated Load	Max. Loa	d Current	_	Response me
		Module	Voltage	Per Point	Per Common	OFF to ON	ON to OFF
AY72 *1	Transistor output (for TTL. COMOS) (sink type)	64 points	5/12VDC	0.016A	0.512A	1ms or less	1ms or less
AY80		16 points		0.5A	2A	2mc of less	2ms of less (resistive load)
AY80EP				0.8A	3.84A	0.5ms or less	1.5ms or less
AY81	Transistor output (source type)	22 nainta	12/24VDC	0.5A	4A	2ms of less	2ms of less (resistive load)
AY81EP		32 points		12VDC 0.8A	7.68A		
AIOIEP				24VDC 0.4A	3.84A	0.5ms or	1.5ms or
*1		64 points		12VDC 0.1A	1.92A	less	less
AY82EP		O T POINTS		24VDC 0.04A	0.758A		

External Connections	Common Terminal Arrangement	Surge Suppression	Fuse Rating	Error Display	External Power Supply (TYP 24VDC) Current	Internal Current Consumption	Number of Occupied I/O Points
40-pin connector × 2	32 points/ common	None	None	None	*12 0.3A	0.3A	64 points
20 terminal block	8 points/	Varistor	2A *6	Display *10	0.06A	0.115A	16 points
connector	common	Surge absorbing diode			0.11A		
38 terminal block	16 points/	Varistor			0.05A	0.23A	32 points
connector	common	Surge	None	None	0.22A	U.23A	oz points
40-pin connector × 2	32 points/ common	absorbing diode			0.05A	0.29A	64 points

The following specifications apply to all modules:

Isolation method : Photocoupler

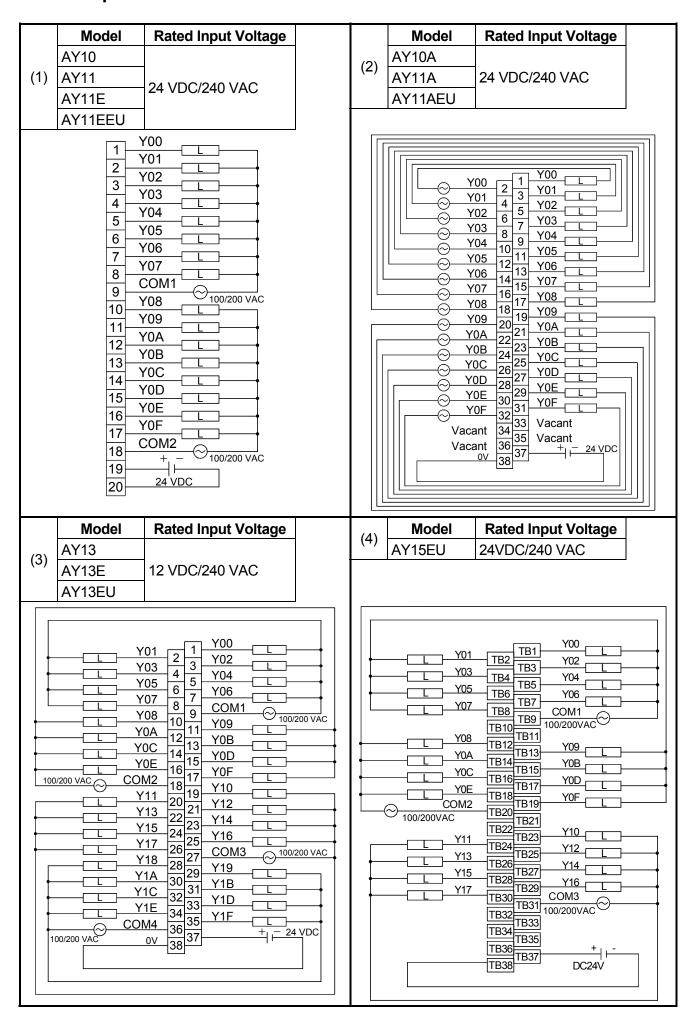
Input indication : LEDs

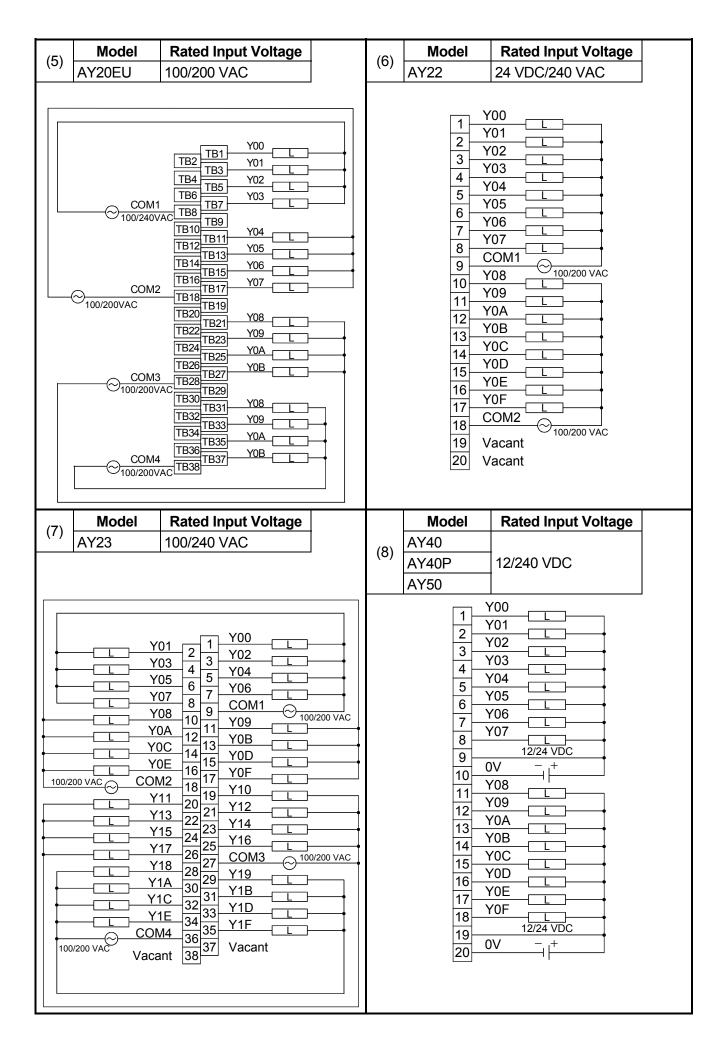
*1 : The ON/OFF status of the first or latter half is indicated by the LEDs in accordance with the setting of the selector switch on the front panel of the module:

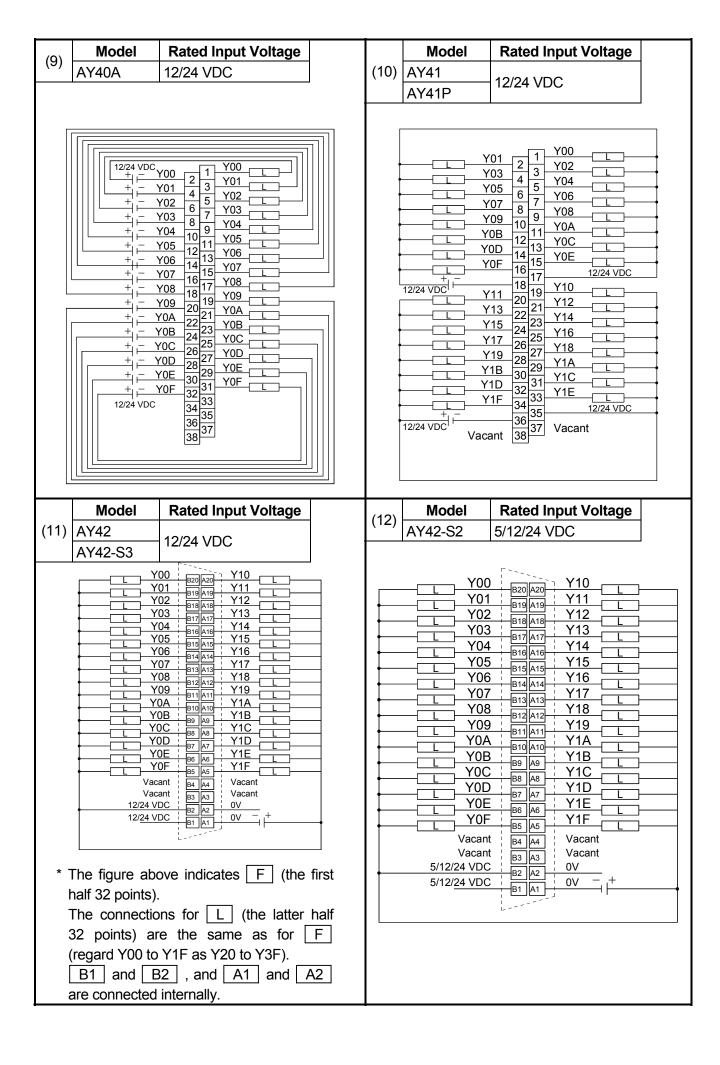
FH setting: First half (Y00 to Y1F), LH setting: Latter half (Y20 to Y3F)

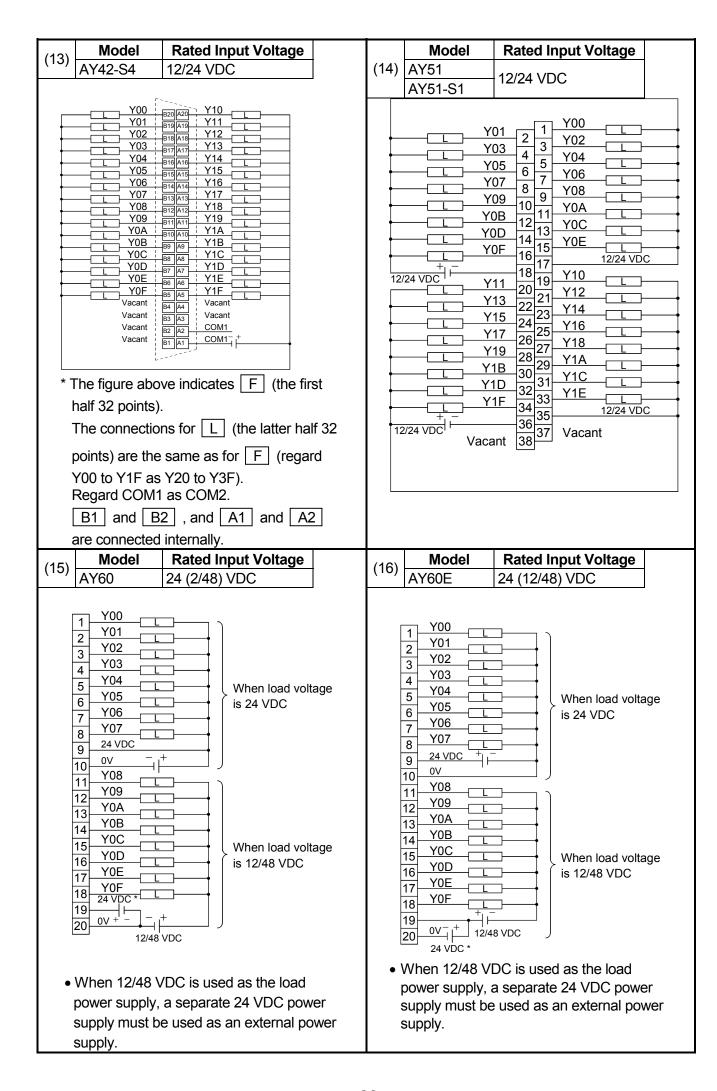
- *2 : When 12/48 VDC is used as the load power supply, a separate 24 VDC power supply must be used as an external power supply.
- *3 : When 12 VDC is used as the load power supply, a separate 24/48 VDC power supply must be used as an external power supply.
- *4 : When the module is installed adjacent to the power supply module, the value indicated in parentheses applies.
- *5 : The maximum load current differs depending on the number of simultaneously ON points.
- *6 : Fast-melting fuse (one per common)
- *7 : Normal fuse (two per common)
- *8 : Fast-melting fuse (two per 8-per-common unit)
- *9 : Fast-melting fuse (two per common)
- *10: LED comes on when a fuse blows or the external power supply is turned off.
- *11: Since this is a built-in fuse directly fixed to the module, replace the entire module if it blows.
- *12: TYP. 12 VDC

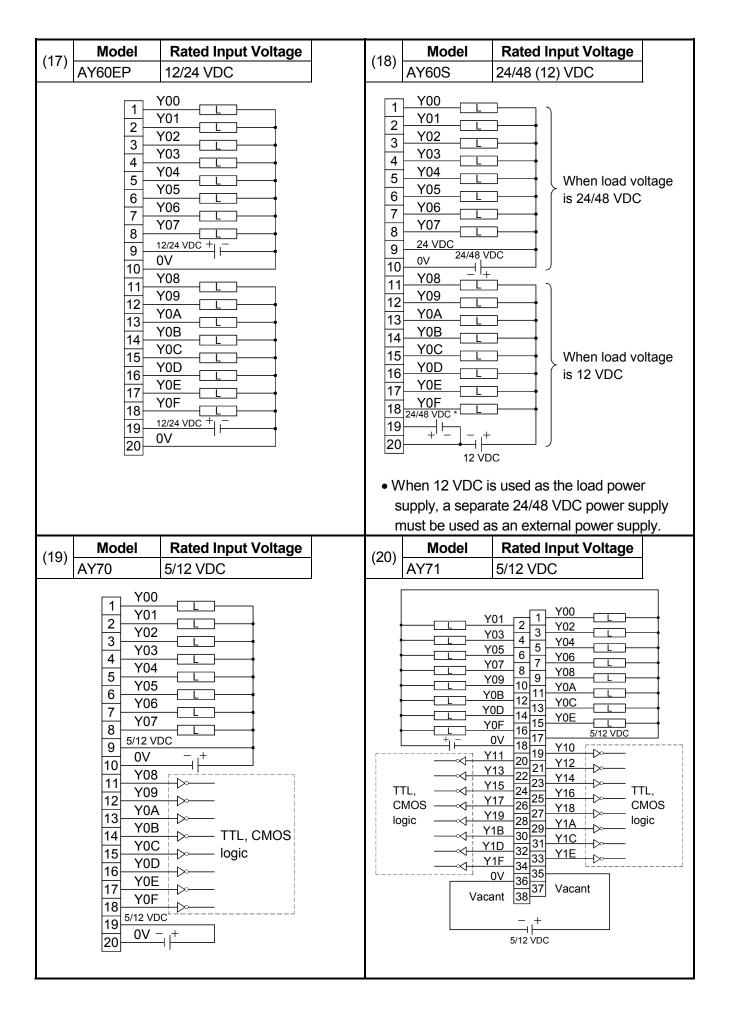
5.2.2 Output module connections

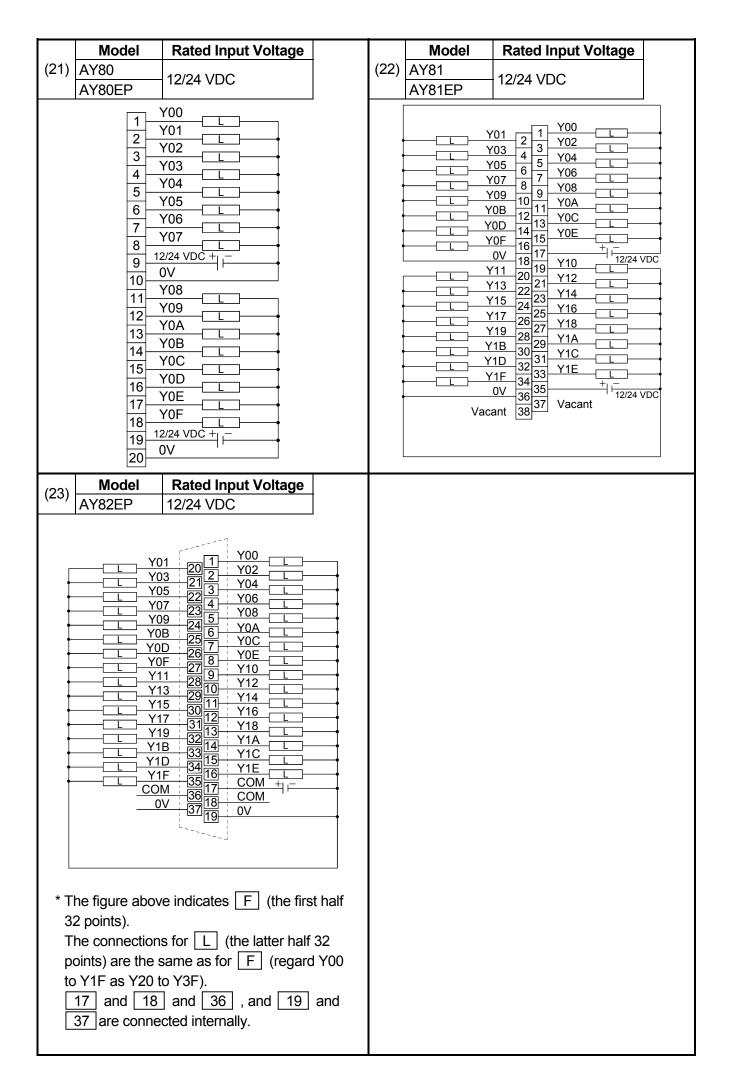


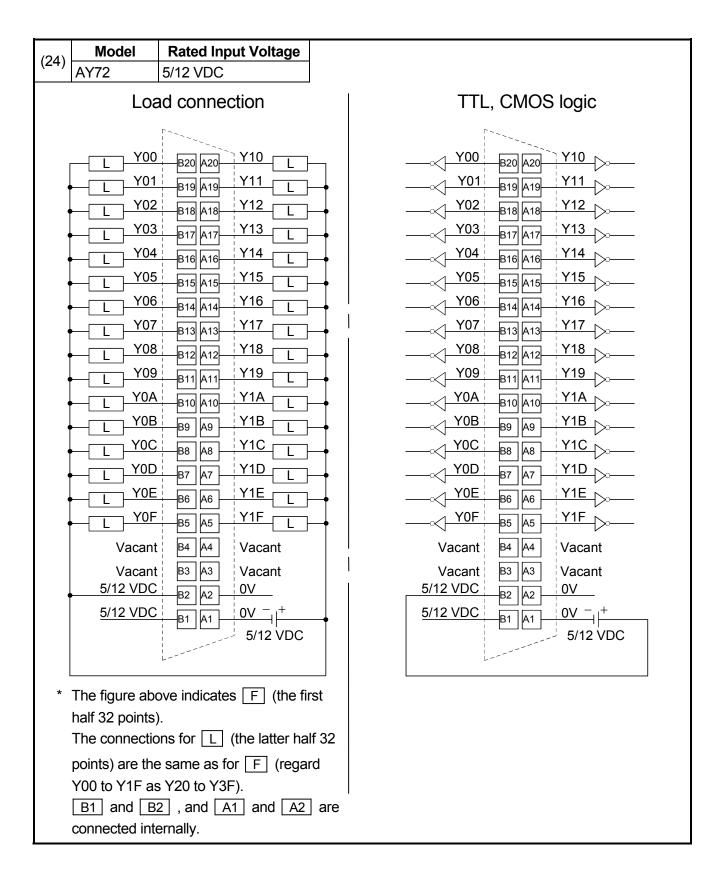












MEMO		

5.3 Input/Output Combined Modules

5.3.1 Input/output combined module specifications

		Number				Operatin	Operating Voltage	
Model	Input Type	of Points/ Module	Isolation Method	Rated Input Voltage	Input Current	ON Voltage	OFF Voltage	
A42XY	Dynamic	64 points	Dhataaayalaa			7VDC or	3VDC or	
	scan	*1	Photocoupler	12/24VDC		hiaher	lower	
AH42	DC input	32 points	insulation	12/24000	3/7mA	9.5VDC or	6VDC or	
Λι 1 1 2	(sink type)	oz points			3//111A	higher	lower	

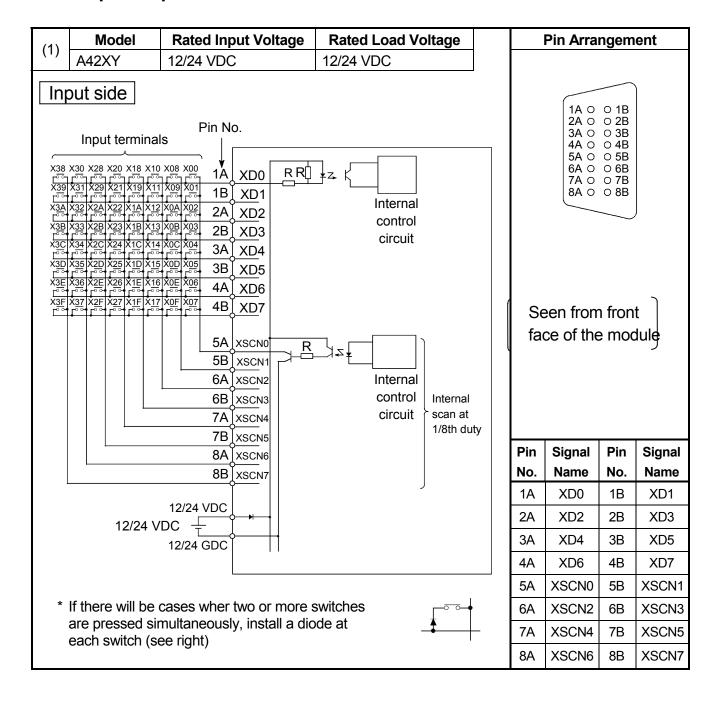
Model	Output Type	Number of Points/	Rated Load	Max. Loa	Max. Load Current		Input Response Time	
		Module	Voltage	Per Point	Per Common	OFF to ON	ON to OFF	
A42XY	Dynamic scan	64 points		50mA	_	16ms or less	16ms or less	
AH42	Transistor output (sink type)	32 points	12/24VDC	0.1A	1A	2ms or less	2ms or less	

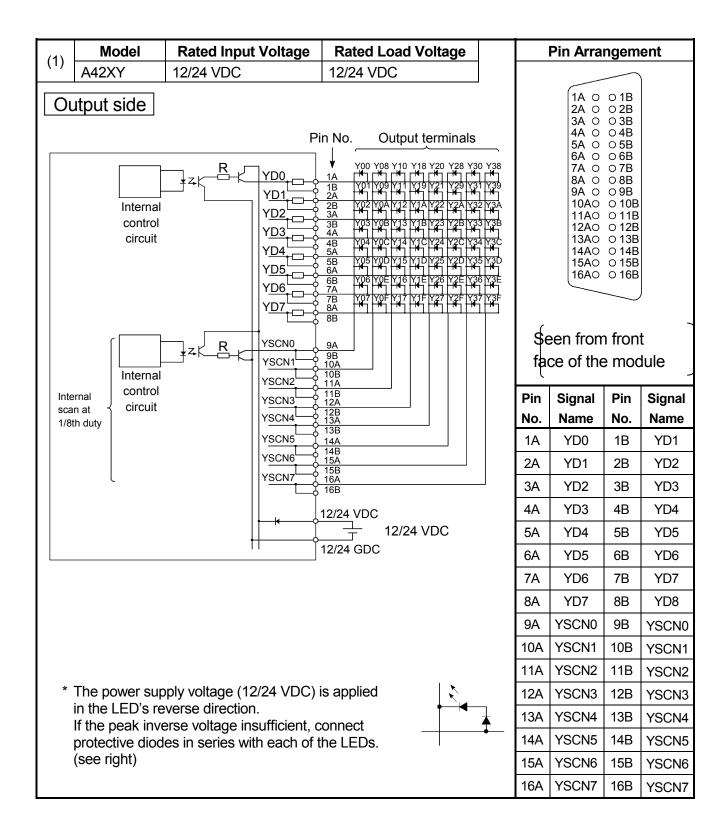
Maximum	Input Respons	e Time			
Simultaneous ON Input Point (Percentage Simultaneous ON)	OFF to ON	ON to OFF	Input Display	External Connections	Common Terminal Arrangement
60%	16ms or less	16ms or less	LED display	16-pin connector	_
33,3	10ms or less	10ms or less	LED display	40-pin connector × 2	30 points/ common

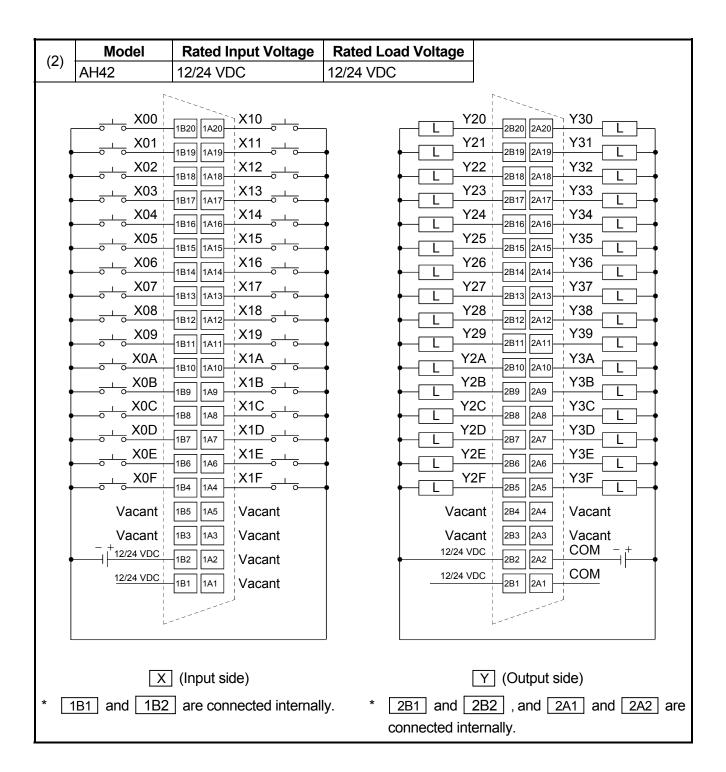
External Connections	Lerminai	Surge Suppression	Fuse Ratting	Error Display	External Power Supply (TYP 24VDC) Current	Internal Current Consumption	Number of Occupied I/O Points
32-pin connector	_	None			0.18A	0.11A	64 points *1
40-pin connector × 2	32 points/ common	Clamp diode	None	None	0.04A	0.245A	64 points *2

- *1 : The same numbers are allocated to both input and output points. The number of occupied I/O points is 64.
- *2 : The first half 32 points are allocated to input and the latter half 32 points are allocated to output. Thus, the number of occupied I/O points is 64. When I/O allocation is carried out at a peripheral device, both modules should be set as 64-point output modules.

5.3.2 Input/output combined module connections







6. ERROR CODE

If an error occurs when the PLC is powered ON, switched to RUN status or running, the QnACPU module executes the self diagnostics function to display the error (LED display, message display) and store the error information into the special relay SM and special register SD.

Also, if an error occurs when a communication request is issued from a peripheral device, special function module or network system, the QnACPU returns the error code (4000H to 4FFFH) to the request source.

The following explains the QnACPU errors and the corresponding corrective actions.

REMARK

The error code of the error that occurred when a general data processing request is made from the peripheral device, special function module or network system is not stored into SD0 of the Q2ASCPU.

The error code is returned to the source of the general data processing request.

6.1 Error Code Type

Errors are detected by the self diagnostics function of CPU module or during communication with CPU module.

The following table classifies the errors according to the detection pattern, detection location and error code.

Error detection pattern	Error detection location	Error code	Reference
Detection by the self diagnostics function of CPU module	CPU module	1000 to 10000*1	Section 6.3
Detection at	CPU module	4000н to 4FFFн	Q2A(S1)/Q3A/Q4ACPU User's Manual
communication with CPU module	Serial communication module, etc.	7000н to 7FFFн	Serial Communication User's Manual, etc.
	CC-Link module	B000н to BFFFн	CC-Link System Master/Local Module User's Manual
	Ethernet module	C000н to CFFFн	Ethernet Interface Module User's Manual
	MELSECNET/H network module	F000н to FFFFн	For QnA/Q4AR MELSECNET/10 Network System Reference Manual

- *1 : CPU module error codes are classified into minor, moderate, major errors as shown below.
 - Minor error: Errors that may allow the CPU module to continue the operation, e.g., battery

error.

(Error code: 1300 to 10000)

• Moderate error: Errors that may cause the CPU module to stop the operation, e.g., WDT error.

(Error code: 1300 to 10000)

• Major error: Errors that may cause the CPU module to stop the operation, e.g., RAM error.

(Error code: 1000 to 1299)

Determine the error level, i.e. whether the operation can be continued or stopped, by referring to "Operating Statuses of CPU" described in Section 6.3 "Error Code List"

6.2 Reading Error Code

When an error occurs, the corresponding error code and error message can be read out using a peripheral device.

For details on peripheral device operation, refer to GX Developer Operating Manual or SW_IVD-GPPQ/SW_NX-GPPQ Operating Manual (Online).

6.3 Error Code List

The following information deals with error codes and the meanings, causes, and corrective measures of error messages.

<Relevant CPU>

C : Indicates all the QnACPUs and QCPU.QCPU : Indicates all the Q series CPU modules.

Q00J/Q00/Q01 : Indicates the Basic model QCPU.

Qn(H) : Indicates the High Performance model QCPU.

QnPH : Indicates the Process CPU.
QnPRH : Indicates the Redundant CPU.

QnA : Indicates the QnA series and Q2ASCPU series.

Rem : Indicates the MELSECNET/H remote I/O modules.

Each CPU module model name: Indicates the relevant specific CPU module.

(Example: Q4AR, Q2AS)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
1000	[MAIN CPU DOWN] Runaway or failure of CPU module or failure of main CPU • Malfunctioning due to noise or other reason • Hardware fault ■Collateral informationmmon • Common Information:— • Individual Information:— ■Diagnostic Timing • Always	Take noise reduction measures. Reset the CPU module and RUN it again. If the same error is displayed again, this suggests a CPU module hardware fault. (Contact your local Mitsubishi representative.)	RUN: Off ERR.: Flicker CPU Status: Stop	
1010	[END NOT EXECUTE] Entire program was executed without the execution of an END instruction. • When the END instruction is executed it is read as another instruction code, e.g. due to noise. • The END instruction has been changed to another instruction code somehow. ■Collateral informationmmon • Common Information:- • Individual Information:- ■Diagnostic Timing • When an END instruction executed	Take noise reduction measures. Reset the CPU module and RUN it again. If the same error is displayed again, this suggests a CPU module hardware fault. (Contact your local Mitsubishi representative.)		QnA
1101	[RAM ERROR] The sequence program storing built-in RAM/ program memory in the CPU module is faulty. ■Collateral informationmmon Common Information: Individual Information: ■Diagnostic Timing At power ON/ At reset/ When an END instruction executed	Take noise reduction measures. Reset the CPU module and RUN it again. If the same error is displayed again,this suggests a CPU module hardware fault.(Contact your local Mitsubishi representative.)		
1102	[RAM ERROR] • The work area RAM in the CPU module is faulty. • The standard RAM and extended RAM in the CPU module are faulty. ■Collateral informationmmon • Common Information:— • Individual Information:— ■Diagnostic Timing • At power ON/ At reset/ When an END instruction executed	Take noise reduction measures. Reset the CPU module and RUN it again. If the same error is displayed again, this suggests a CPU module hardware fault.(Contact your local Mitsubishi representative.)		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
1103	[RAM ERROR] The device memory in the CPU module is faulty. ■Collateral informationmmon • Common Information:- • Individual Information:- ■Diagnostic Timing • At power ON/At reset	Take noise reduction measures. When indexing is performed, check the value of index register to see if it is within the device range. Reset the CPU module and RUN it again. If the same error is displayed again,this suggests a CPU module hardware fault.(Contact your local Mitsubishi representative.)		QnA
1104	[RAM ERROR] The address RAM in the CPU module is faulty. ■Collateral informationmmon Common Information:— Individual Information:— ■Diagnostic Timing At power ON/At reset	Take noise reduction measures. Reset the CPU module and RUN it again.If the same error is displayed again, this suggests a CPU module hardware fault. (Contact your local Mitsubishi representative.)		
1105	[RAM ERROR] The system RAM in the CPU module is faulty. ■Collateral informationmmon • Common Information:- • Individual Information:- ■Diagnostic Timing • At power ON/At reset	Take noise reduction measures. Reset the CPU module and RUN it again.If the same error is displayed again, this suggests a CPU module hardware fault. (Contact your local Mitsubishi representative.)		Q4AR
1200	[OPE. CIRCUIT ERR.] The operation circuit for index modification in the CPU module does not operate normally. ■Collateral informationmmon • Common Information:— • Individual Information:— ■Diagnostic Timing • At power ON/At reset		RUN: Off ERR.: Flicker CPU Status: Stop	
1201	[OPE. CIRCUIT ERR.] The hardware (logic) in the CPU module does not operate normally. ■Collateral informationmmon • Common Information:- • Individual Information:- ■Diagnostic Timing • At power ON/At reset			QnA
1202	[OPE. CIRCUIT ERR.] The operation circuit for sequence processing in the CPU module does not operate normally. Collateral informationmmon Common Information: Individual Information: Diagnostic Timing At power ON/At reset	This suggests a CPU module hardware fault. (Contact your local Mitsubishi representative.)		
1203	[OPE. CIRCUIT ERR.] The operation circuit for index modification in the CPU module does not operate normally. ■Collateral informationmmon • Common Information:- • Individual Information:- ■Diagnostic Timing • When an END instruction executed			Q4AR
1204	[OPE. CIRCUIT ERR.] The hardware (logic) in the CPU module does not operate normally. ■Collateral informationmmon • Common Information:— • Individual Information:— ■Diagnostic Timing • When an END instruction executed			YA+W

Error	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding
Code 1205	[OPE. CIRCUIT ERR.] The operation circuit for sequence processing in the CPU module does not operate normally. Collateral informationmmon Common Information: Individual Information: Diagnostic Timing		RUN: Off ERR.:	CPU QnA
1206	When an END instruction executed [OPE. CIRCUIT ERR.] The DSP operation circuit in the CPU module does not operate normally. [Collateral informationmmon Common Information:— Individual Information:— [Diagnostic Timing When instruction executed]	This suggests a CPU module hardware fault. (Contact your local Mitsubishi representative.)	Flicker CPU Status: Stop	Q4AR
	[FUSE BREAK OFF] There is an output module with a blown fuse. ■Collateral informationmmon • Common Information:Module No.(Slot No.) [For Remote I/O network] Network No./Station No. • Individual Information:— ■Diagnostic Timing • Always	Check ERR. LED of the output modules and replace the fuse of the module whose LED is lit. Read the common information of the error using the peripheral device and replace the fuse at the output module corresponding to the numerical value (module No.) reading. Alternatively, monitor special registers SD1300 to SD1331 with the peripheral device and change the fuse of the output module whose bit has a value of "1". When a GOT is bus-connected to the main base unit or extension base unit, check the connection status of the extension cable and the grounding status of the GOT.	RUN: Off/On ERR.:	QnA Q4AR
1300	[FUSE BREAK OFF] • There is an output module with a blown fuse. • External power supply for output load is turned off or disconnected. ■Collateral informationmmon • Common Information:Module No.(Slot No.) [For Remote I/O network] Network No./Station No. • Individual Information:— ■Diagnostic Timing • Always	Check ERR. LED of the output modules and replace the module whose LED is lit. Read the common information of the error using the peripheral device and replace the fuse at the output module corresponding to the numerical value (module No.) reading. Alternatively, monitor special registers SD1300 to SD1331 with the peripheral device and change the fuse of the output module whose bit has a value of "1". Check whether the external power supply for output load is ON or OFF. When a GOT is bus-connected to the main base unit or extension base unit, check the connection status of the extension cable and the earth status of the GOT.	Flicker/On CPU Status: Stop/ Continue*1	Q2AS
1310	[I/O INT. ERROR] An interruption has occurred although there is no interrupt module. Collateral informationmmon Common Information: Individual Information: Diagnostic Timing During interrupt	Any of the mounted modules is experiencing a hardware fault. Therefore, check the mounted modules and change the faulty module. (Contact your local Mitsubishi representative.)	RUN: Off ERR.: Flicker CPU Status: Stop	
1401	[SP. UNIT DOWN] When PLC parameter I/O allocation was being made, there was no return signal from the special function module during initial processing stage.(When error is generated, the head I/O number of the special function module that corresponds to the common information is stored.) Collateral informationmmon Common Information:Module No.(Slot No.) Individual Information:— Diagnostic Timing At power ON/At reset	The CPU module, base unit and/or the special function module that was accessed is experiencing a hardware fault. (Contact your local Mitsubishi representative.)	RUN: Off ERR.: Flicker CPU Status: Stop*2	QnA

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

^{*2} The BAT.ALM LED turns on at BATTERY ERROR.

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
1402	[SP. UNIT DOWN] The special function module was accessed during the execution of a FROM/TO instruction set, but there was no response. (When an error is generated, the program error location corresponding to the individual information is stored.) ■Collateral informationmmon Common Information:Module No.(Slot No.) Individual Information:Program error location ■Diagnostic Timing During execution of FROM/TO instruction set	The CPU module, base unit and/or the special function module that was accessed is experiencing a hardware fault.(Contact your local Mitsubishi representative.)		5.7 0
1411	[CONTROL-BUS. ERR.] When performing a parameter I/O allocation the intelligent function module/special function module could not be accessed during initial communications. (On error occurring, the head I/O number of the corresponding intelligent function module/special function module is stored in the common information.) ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON / At reset [CONTROL-BUS. ERR.] The FROM/TO instruction is not executable, due to a control bus error with the intelligent function module/special function module. (On error occurring, the program error location is stored in the individual information.) ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:Program error location ■Diagnostic Timing • During execution of FROM/TO instruction set	Reset the CPU module and RUN it again. If the same error is displayed again, the intelligent function module/special function module, CPU module or base unit is faulty. (Contact your local Mitsubishi representative.)	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
1421	[SYS. UNIT DOWN] Hardware fault at the system management module AS92R. Collateral informationmmon Common Information: Individual Information: Diagnostic Timing Always	This suggests a system management module AS92R hardware fault. (Contact your local Mitsubishi representative.)		Q4AR
1500	[AC/DC DOWN] • A momentary power supply interruption has occurred. • The power supply went off. ■Collateral informationmmon • Common Information:— • Individual Information:— ■Diagnostic Timing • Always	Check the power supply.	RUN: On ERR.: Off CPU Status: Continue	QnA

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
1510	[DUAL DC DOWN 5V] The power supply voltage (100 to 240VAC) of either of the two power supply modules on the power supply duplexing extension base unit dropped to or below 85% of the rated voltage. (This can be detected from the control system of the redundant system.) ■Collateral informationmmon • Common Information:— • Individual Information:— ■Diagnostic Timing • Always	Check the supply voltage of the power supply module. If the voltage is abnormal then replace the power supply module.	RUN: On ERR.: On CPU Status: Continue	GI U
1520	[DC DOWN 5V] The voltage(100 to 240VAC) of the power supply module on the extension base unit dropped to or below 85% of the rated voltage. (This can be detected from the control system of the stand-alone system or redundant system.) ■Collateral informationmmon • Common Information: • Individual Information: ■Diagnostic Timing • Always	Check the supply voltage of the power supply module. If the voltage is abnormal then replace the power supply module.	RUN: Off ERR.: Flicker CPU Status: Stop	Q4AR
1530	[DC DOWN 24V] The 24 VDC power supplied to the system management module AS92R has dropped below 90% of the rated voltage. (This can be detected from the control system or standby system of the redundant system.) ■Collateral informationmmon • Common Information:— • Individual Information:— ■Diagnostic Timing • Always	Check the 24VDC power supplied to the system management module AS92R.	RUN: On ERR.: On CPU Status: Continue	
1600	[BATTERY ERROR*2] • The battery voltage in the CPU module has dropped below stipulated level. • The lead connector of the CPU module battery is not connected. ■Collateral informationmmon • Common Information:Drive Name • Individual Information:— ■Diagnostic Timing • Always	Change the battery. If the battery is for program memory, standard RAM or for the back-up power function, install a lead connector.	RUN: On ERR.: Off CPU Status: Continue	
1601	[BATTERY ERROR*2] Voltage of the battery on memory card 1 has dropped below stipulated level. ■Collateral informationmmon • Common Information:Drive Name • Individual Information:— ■Diagnostic Timing • Always	Change the battery.		QnA
1602	[BATTERY ERROR*2] Voltage of the battery on memory card 2 has dropped below stipulated level. ■Collateral informationmmon • Common Information:Drive Name • Individual Information:— ■Diagnostic Timing • Always	Change the battery.	RUN: On ERR.: On CPU Status: Continue	

^{*2} The BAT.ALM LED turns on at BATTERY ERROR.

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
2000	[UNIT VERIFY ERR.] I/O module information power ON is changed. • I/O module (or special function module) not installed properly or installed on the base unit. ■Collateral informationmmon • Common Information:Module No.(Slot No.) [For Remote I/O network] Network No./Station No. • Individual Information:— ■Diagnostic Timing • When an END instruction executed	Read the common information of the error using the peripheral device, and check and/or change the module that corresponds to the numerical value (module number) there. Alternatively, monitor the special registers SD1400 to SD1431 at a peripheral device, and change the fuse at the output module whose bit has a value of "1". When a GOT is bus-connected to the main base unit or extension base unit, check the connection status of the extension cable and the grounding status of the GOT.	RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	
2100	[SP. UNIT LAY ERR.] In PLC parameter I/O allocation settings, a special function module was allocated to a location reserved for an I/O module. Or, the opposite has happened. ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Reset the PLC parameter I/O allocation setting to conform with the actual status of the special function modules.	RUN: Off ERR.: Flicker CPU Status: Stop	
2101	[SP. UNIT LAY ERR.] 13 or more special function modules (not counting the A1SI61) capable of sending an interrupt to the CPU module have been installed. Collateral informationmmon Common Information:Module No.(Slot No.) Individual Information:— Diagnostic Timing At power ON/At reset	Keep the number of special function modules that can initiate an interrupt (with the exception of the A(1S)I61 module) to 12 or fewer.		QnA
2102	[SP. UNIT LAY ERR.] Seven or more serial communication modules (excludes A (1S) J71QC24) have been installed. ■Collateral informationnmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Keep the number of serial communication modules (excludes A(1S)J71QU24) installed to six or fewer.		
2103	[SP. UNIT LAY ERR.] Two or more A (1S) I61 interrupt modules have been mounted. ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Install only 1 A (1S) l61 module.		

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error	Error Contents and Cause	Corrective Action	LED Status	Corresponding
Code	LITOI COINEIRS AND CAUSE	Corrective Action	CPU Status	CPU
2104	[SP. UNIT LAY ERR.] At the MELSECNET/MINI auto refresh network parameter settings, the module allocation that was set is different from the actual module models at the station numbers in the link system. ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Reset the network parameter MELSECNET/MINI auto refresh unit module allocation setting so that it conforms to the station number of the module that is actually linked.		
2105	[SP. UNIT LAY ERR.] There are too many special function modules that can use dedicated instructions allocated (number of modules installed). (The total of the figures indicated below is above 1344.) (AD59 modules installed × 5) modules installed × 5) modules installed × 8) (AJ71C24(S3/S6/S8) modules installed × 10) (AJ71UC24 modules installed × 10) (AJ71UC24 modules installed × 29) (AJ71PT32-S3/AJ71T32-S3 modules installed × 29) (AJ71D1(2)-R4 modules installed × 29) (AJ71D1(2)-R4 modules installed × 29) modules installed × 29) (AJ71D1(2)-R4 modules installed × 12) total > 1344 *: When the expansion mode is used. ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Reduce the number of special function modules installed.	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
2106	[SP.UNIT LAY ERR.] • Five or more AJ71QLP21 & AJ71QBR11 modules are installed. • Three or more AJ71AP21/R21 & AJ71AT21B modules are installed. • The total number of installed AJ71QLP21, AJ71QBR11, AJ71AP21/R21, and AJ71AT21B modules exceeds five. • The same network numbers or identical station numbers exist in the MELSECNET/10 network system. • Two or more master or load stations exist simultaneously at the MELSECNET(II) or MELSECNET/B data link system. ■Collateral informationmmon • Common Information:Module No. (Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Reduce the AJ71QLP21 and AJ71QBR11 modules to four or less. Reduce the AJ71AP21/R21 and AJ71AT21B modules to two or less. Reduce the AJ71QLP21, AJ71QBR11, AJ71AP21/R21 and AJ71AT21B modules to a total of four or less. Check the network Nos. and station Nos. Check the station Nos.		
2107	• At power ON/At reset [SP. UNIT LAY ERR.] The start X/Y set in the PLC parameter's I/O assignment settings is overlapped with the one for another module. ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Make the PLC parameter's I/O assignment setting again so it is consistent with the actual status of the special function modules.		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
2108	[SP. UNIT LAY ERR.] A(1S)J71LP21 or A(1S)J71BR11 for use with the AnUCPU network module has been installed. ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Replace the network module to A(1S)J71QLP21 or A(1S)J71QBR11.	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
2109	[SP. UNIT LAY ERR.] The control system and standby system module configurations are different when a redundant system is in the backup mode. ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Check the module configuration of the standby system.	RUN: Off ERR.: Flicker CPU Status: Stop/ Continue*2	Q4AR
2110	[SP. UNIT ERROR] • The location designated by the FROM/TO instruction set is not the special function module. • The module that does not include buffer memory has been specified by the FROM/TO instruction. • The special function module, Network module being accessed is faulty. • Station not loaded was specified using the instruction whose target was the CPU share memory. ■Collateral informationmmon • Common Information:Module No.(Slot No.) • Individual Information:Program error location ■Diagnostic Timing • When instruction executed [SP. UNIT ERROR]	Read the individual information of the error using the GX Developer, check the FROM/TO instruction that corresponds to that numerical value (program error location), and correct when necessary. The special function module that was accessed is experiencing a hardware fault. Therefore, change the faulty module. Alternatively, contact	RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	
2111	The location designated by a link direct device (J□ \□) is not a network module. The I/O module (special function module) was nearly removed, completely removed, or mounted during running. ■Collateral informationmmon Common Information:Module No.(Slot No.) Individual Information:Program error location ■Diagnostic Timing When instruction executed	your local Mitsubishi representative.		QnA
2112	 [SP. UNIT ERROR] The module other than special function module is specified by the special function module dedicated instruction. Or, it is not the corresponding special function module. The module model specified by the special function module dedicated instruction and that specified by the parameter I/O assignment is different. ■Collateral informationmmon Common Information:Module No.(Slot No.) Individual Information:Program error location ■Diagnostic Timing When instruction executed/STOP → RUN 	Read the individual information of the error using a peripheral device, and check the special function module dedicated instruction (network instruction) that corresponds to the value (program error part) to make modification. Set the module model by PLC parameter I/O assignment according to the special function module dedicated instruction setting. Example) Although AJ71QC24N is used actually, AJ71QC24 is set.		

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

^{*2} The BAT.ALM LED turns on at BATTERY ERROR.

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
2113	[SP. UNIT ERROR] Data of special function module to be simulated is not set in the simulation date. ■Collateral informationmmon • Common Information:FFFFH (fixed) • Individual Information:Program error location ■Diagnostic Timing • When instruction executed/STOP → RUN	Read the individual information of the error using a peripheral device, and check the special function module /special function module dedicated instruction (network instruction) that corresponds to the value (program error part) to make modification.	RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1 RUN: Off ERR.: Flicker CPU Status: Stop RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	QnA
2210	[BOOT ERROR] There is no boot file in the drive designated by the parameter enabled drive switch even though the Boot DIP switch is ON. Collateral informationmmon Common Information:Drive name Individual Information:— Diagnostic Timing At power ON/At reset	Check and correct the valid parameter drive settings made by the DIP switches. Set the boot file to the drive specified by the parameter drive DIP switches.		
2300	[ICM. OPE. ERROR] • A memory card was removed without switching the memory card in/out switch OFF. • The memory card in/out switch is turned ON although a memory card is not actually installed. ■Collateral informationmmon • Common Information:Drive name • Individual Information:— ■Diagnostic Timing • When memory card is inserted or removed/When memory card is inserted	Remove memory card after placing the memory card in/out switch OFF. Turn on the card insert switch after inserting a memory card.		
2301	[ICM. OPE. ERROR] • The memory card has not been formatted. • Memory card format status is incorrect. ■Collateral informationmmon • Common Information:Drive name • Individual Information:— ■Diagnostic Timing • When memory card is inserted or removed/When memory card is inserted	Format memory card. Reformat memory card.		
2302	[ICM. OPE. ERROR] A memory card that cannot be used with the CPU module has been installed. Collateral informationmmon Common Information:Drive name Individual Information:— Diagnostic Timing When memory card is inserted or removed	Format memory card. Reformat memory card. Check memory card.		
2400	[FILE SET ERROR] The file designated at the PLC file settings in the parameters cannot be found. ■Collateral informationmmon Common Information:File name/Drive name Individual Information:Parameter number ■Diagnostic Timing At power ON/At reset/ At writing to progurammable controller	Read the individual information of the error using peripheral device, check to be sure that the parameter drive name and file name correspond to the numerical values there (parameter number), and correct. Create a file created using parameters, and load it to the CPU module.		

 $^{^{\}star}1$ $\,$ CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
2401	[FILE SET ERROR] The file specified by parameters cannot be made. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/ At writing to progurammable controller	Read the individual information of the error using the peripheral device, check to be sure that the parameter drive name and file name correspond to the numerical values there (parameter number), and correct. Check the space remaining in the memory card.	RUN: Off - ERR.: Flicker CPU Status: Stop	QnA
2402	[FILE SET ERROR] Though the file register has been set in the pairing setting/tracking setting, the file register does not exist. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/ At writing to progurammable controller	Confirm the file register and parameter.		Q4AR
2410	[FILE OPE. ERROR] • The specified program does not exist in the program memory. This error may occur when the ECALL, EFCALL, PSTOP, PSCAN, POFF or PLOW instruction is executed. • The specified file does not exist. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Program error location ■Diagnostic Timing • When instruction executed	Read the individual information of the error using the peripheral device, check to be sure that the program corresponds to the numerical values there (program location), and correct. Create a file created using parameters, and load it to the CPU module. In case a specified file does not exist, write the file to a target memory and/or check the file specified with the instruction again.	RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	
2411	 FILE OPE. ERROR] The file is the one which cannot be specified by the sequence program (such as comment file). The specified program exists in the program memory, but has not been registered in the program setting of the Parameter dialog box. This error may occur when the ECALL, EFCALL, PSTOP, PSCAN or POFF instruction is executed. ■Collateral informationmmon Common Information:File name/Drive name Individual Information:Program error location ■Diagnostic Timing When instruction executed 	Read the individual information of the error using the peripheral device, check to be sure that the program corresponds to the numerical values there (program location), and correct.		QnA
2412	[FILE OPE. ERROR] The SFC program file is one that cannot be designated by the sequence program. ■Collateral informationmmon Common Information:File name/Drive name Individual Information:Program error location ■Diagnostic Timing When instruction executed	Read the individual information of the error using the peripheral device, check to be sure that the program corresponds to the numerical values there (program location), and correct.		
2413	[FILE OPE. ERROR] No data has been written to the file designated by the sequence program. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Program error location ■Diagnostic Timing • When instruction executed	Read the individual information of the error using the peripheral device, check to be sure that the program corresponds to the numerical values there (program location), and correct. Check to ensure that the designated file has not been write protected.		

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
2500	[CAN'T EXE. PRG.] • There is a program file that uses a device that is out of the range set in the PLC parameter device setting. • After the PLC parameter setting is changed, only the parameter is written into the PLC. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:— ■Diagnostic Timing • At power ON/At reset	Read the common information of the error using the peripheral device, check to be sure that the parameter device allocation setting and the program file device allocation correspond to the numerical values there (file name), and correct if necessary. If PLC parameter device setting is changed, batch-write the parameter and program file into the PLC.	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
2501	[CAN'T EXE. PRG.] There are multiple program files although "none" has been set at the PLC parameter program settings. Collateral informationmmon Common Information:File name/Drive name Individual Information: Diagnostic Timing At power ON/At reset	Edit the PLC parameter program setting to "yes". Alternatively, delete unneeded programs.		
2502	[CAN'T EXE. PRG.] The program file is incorrect. Alternatively, the file contents are not those of a sequence program. Collateral informationmmon Common Information:File name/Drive name Individual Information: Diagnostic Timing At power ON/At reset	Check whether the program version is * * * .QPG, and check the file contents to be sure they are for a sequence program.		
2503	[CAN'T EXE. PRG.] There are no program files at all. Collateral informationmmon Common Information:File name/Drive name Individual Information: Diagnostic Timing At power ON/At reset	Charle program configuration		
2504	[CAN'T EXE. PRG.] Two or more SFC normal programs or control programs have been designated. Collateral informationmmon Common Information:File name/Drive name Individual Information:— Diagnostic Timing At power ON/At reset	Check program configuration. Check parameters and program configuration.		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
3000	[PARAMETER ERROR] The PLC parameter settings for timer time limit setting, the RUN-PAUSE contact, the common pointer number, general data processing, number of empty slots, system interrupt settings, baud rate setting, and service processing setting are outside the range that can be used by the CPU module. ■Collateral informationnmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN/ At writing to progurammable controller [PARAMETER ERROR] The parameter settings in the error individual information (special register SD16) are illegal. ■Collateral informationmmon • Common Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN/ At writing to progurammable controller	 Read the individual information of the error using the peripheral device, check the parameter item corresponding to the numerical value (parameter No.), and correct it. Rewrite corrected parameters to the CPU module, reload the CPU power supply and/or reset the module. If the same error occurs, it is thought to be a hardware error. (Contact your local Mitsubishi representative.) 	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
3001	[PARAMETER ERROR] The parameter settings are corrupted. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN/ At writing to progurammable controller			
3002	[PARAMETER ERROR] When "Use the following file" is selected for the file register in the PLC file setting of the PLC parameter dialog box, the specified file does not exist although the file register capacity has been set. ■Collateral informationnmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN/ At writing to progurammable controller	Read the individual information of the error using the peripheral device, check the parameter item corresponding to the numerical value (parameter No.), and correct it. Rewrite corrected parameters to the CPU module, reload the CPU power supply and/or reset the module. If the same error occurs, it is thought to be a hardware error. (Contact your local Mitsubishi representative.)		

Error Code	Error Contents and Cause	Corrective Action	LED Status	Corresponding CPU
3003	[PARAMETER ERROR] ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • When an END instruction executed [PARAMETER ERROR] The number of devices set at the PLC parameter device settings exceeds the possible CPU module range. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power-On/At reset/STOP → RUN/ At writing to progurammable controller	Read the individual information of the error using the peripheral device, check the parameter item corresponding to the numerical value (parameter No.), and correct it. If the error is still generated following the correction of the parameter settings, the possible cause is the memory errorm of the CPU module's built-in RAM or program memory or the memory card. (Contact your local Mitsubishi representative.)	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
3004	[PARAMETER ERROR] The parameter file is incorrect. Alternatively, the contents of the file are not parameters. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power-On/At reset/STOP → RUN/ At writing to progurammable controller	Check whether the parameter file version is $***$ QPA, and check the file contents to be sure they are parameters.		
3100	[LINK PARA. ERROR] Although the QnACPU is a control station or master station, the network parameters have not been written. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN	Correct and write the network parameters. If the error occurs after correction, it suggests a hardware fault. (Contact your local Mitsubishi representative.)		
3101	 [LINK PARA. ERROR] The network No. specified by a network parameter is different from that of the actually mounted network. The head I/O No. specified by a network parameter is different from that of the actually mounted I/O unit. The network class specified by a network parameter is different from that of the actually mounted network. The network refresh parameter of the MELSECNET/H, MELSECNET/10 is out of the specified area. ■Collateral informationmmon Common Information:File name/Drive name Individual Information:Parameter number ■Diagnostic Timing At power ON/At reset/STOP → RUN 	Check the network parameters and mounting status, and if they differ, match the network parameters and mounting status. If any network parameter has been corrected, write it to the CPU module. Confirm the setting of the number of extension stages of the extension base units. Check the connection status of the extension base units and extension cables. When the GOT is bus-connected to the main base unit and extension base units, also check their connection status. If the error occurs after the above checks, the cause is a hardware fault. (Contact your local Mitsubishi representative, explaining a detailed description of the problem.)		
3102	[LINK PARA. ERROR] • The network module detected a network parameter error. ■Collateral informationmmon • Common Information:File name/Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN*3	Correct and write the network parameters. If the error occurs after correction, it suggests a hardware fault. (Contact your local Mitsubishi representative.)		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
3103	 LINK PARA. ERROR] Although the number of modules has been set to one or greater number in the Ethernet network parameter setting, the number of actually mounted module is zero. The start I/O No. of the Ethernet network parameter differs from the I/O No. of the actually mounted module. ■Collateral informationmmon Common Information:File name/Drive name Individual Information:Parameter number ■Diagnostic Timing At power ON/At reset/STOP → RUN [LINK PARA. ERROR] AJ71QE71 does not exist in the position of I/O number set by the parameter. I/O number designation is overlapping. Numbers of the network parameter and loaded AJ71QE71 are different. Ethernet (parameter + dedicated instruction) is set to more than five. ■Collateral information:File name/Drive name Individual Information:Parameter number ■Diagnostic Timing At power ON/At reset/STOP → RUN [LINK PARA. ERROR] The Ethernet and MELSECNET/10 use the same network number. The network number, station number or group number set in the network parameter is out of range. The specified I/O number is outside the range of the used CPU module. The Ethernet-specific parameter setting is not normal. ■Collateral information:File name / Drive name Individual Information:Parameter number ■Diagnostic Timing At power ON/At reset/STOP → RUN 	Correct and write the network parameters. If the error occurs after correction, it suggests a hardware fault. (Contact your local Mitsubishi representative.)	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
3105	[LINK PARA. ERROR] The contents of the Ethernet parameter are incorrect. ■Collateral informationmmon • Common Information:File name / Drive name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN	Write after correcting parameters.		
3107	 [LINK PARA. ERROR] • The CC-Link parameter setting is incorrect. • The set mode is not allowed for the version of the mounted CC-Link module. ■Collateral informationmmon • Common Information:File name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN 	Check the parameter setting.		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
3200	[SFC PARA. ERROR] The parameter setting is illegal. • Though Block 0 was set to "Automatic start" in the SFC setting of the PLC parameter dialog box, Block 0 does not exist. ■Collateral informationmmon • Common Information:File name • Individual Information:Parameter number ■Diagnostic Timing • STOP → RUN	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
3201	[SFC PARA. ERROR] The block parameter setting is illegal. ■Collateral informationmmon • Common Information:File name • Individual Information:Parameter number ■Diagnostic Timing • STOP → RUN			
3202	[SFC PARA. ERROR] The number of step relays specified in the device setting of the PLC parameter dialog box is less than that used in the program. ■Collateral informationmmon • Common Information:File name • Individual Information:Parameter number ■Diagnostic Timing • STOP → RUN			
3203	[SFC PARA. ERROR] The execution type of the SFC program specified in the program setting of the PLC parameter dialog box is other than scan execution. ■Collateral informationmmon • Common Information:File name • Individual Information:Parameter number ■Diagnostic Timing • At power ON/At reset/STOP → RUN			

^{*3} The diagnostic timing of CPU modules except for Universal QCPU can be performed only when switching the CPU modules to run.

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4000	[INSTRCT. CODE ERR] • The program contains an instruction code that cannot be decoded. • An unusable instruction is included in the program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • At power ON/At reset/STOP → RUN			
4001	When instruction executed [INSTRCT. CODE ERR] The program contains a dedicated instruction for SFC although it is not an SFC program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • At power ON/At reset/STOP → RUN When instruction executed			
4002	[INSTRCT. CODE ERR] • The name of dedicated instruction specified by the program is incorrect. • The dedicated instruction specified by the program cannot be executed by the specified module. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • At power ON/At reset/STOP → RUN	Read the common information of the error using a peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
4003	When instruction executed [INSTRCT. CODE ERR] The number of devices for the dedicated instruction specified by the program is incorrect. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • At power ON/At reset/STOP → RUN When instruction executed			
4004	[INSTRCT. CODE ERR] The device which cannot be used by the dedicated instruction specified by the program is specified. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • At power ON/At reset/STOP → RUN When instruction executed			

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4010	[MISSING END INS.] There is no END (FEND) instruction in the program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • At power ON/At reset/STOP → RUN [CAN'T SET(P)] The total number of internal file pointers used by the program exceeds the number of internal file pointers set in the parameters.			
4020	■Collateral informationmmon Common Information:Program error location Individual Information: ■Diagnostic Timing At power ON/At reset/STOP → RUN	Read the common information of the error using a peripheral device, check error step corresponding	RUN: Off ERR.: Flicker	
4021	 [CAN'T SET(P)] The common pointer Nos. assigned to files overlap. The local pointer Nos. assigned to files overlap. ■Collateral informationmmon Common Information:Program error location Individual Information:- ■Diagnostic Timing At power ON/At reset/STOP → RUN 	to its numerical value (program error location), and correct the problem.	CPU Status: Stop	
4030	[CAN'T SET(I)] The allocation pointer Nos. assigned by files overlap. ■Collateral informationmmon Common Information:Program error location Individual Information:— ■Diagnostic Timing At power ON/At reset/STOP → RUN			QnA
4100	[OPERATION ERROR] The instruction cannot process the contained data. ■Collateral informationmmon Common Information:Program error location Individual Information: ■Diagnostic Timing When instruction executed			
4101	[OPERATION ERROR] • The number of setting data dealt with the instruction exceeds the applicable range. • The storage data and constant of the device specified by the instruction exceeds the applicable range. • When writing to the host CPU shared memory, the write prohibited area is specified for the write destination address. • The range of storage data of the device specified by the instruction is duplicated. • The device specified by the instruction exceeds the range of the number of device points. • The interrupt pointer No. specified by the instruction exceeds the applicable range. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4102	COPERATION ERROR	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	QnA
4104	[OPERATION ERROR] The number of settings is beyond the range. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Read the common information of the error using peripheral device, and check and correct the program corresponding to that value (program error location).		Q4AR
4107	[OPERATION ERROR] Numbers of execution to the CC-Link instruction are beyond 32. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Set the numbers of execution to the CC-Link instruction to 32 or less.		
4108	[OPERATION ERROR] The CC-Link parameter is not set when the CC-Link instruction is executed. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Execute the CC-Link instruction after setting the CC-Link parameter.		QnA
4200	[FOR NEXT ERROR] No NEXT instruction was executed following the execution of a FOR instruction. Alternatively, there are fewer NEXT instructions than FOR instructions. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off ERR.: Flicker CPU Status: Stop	

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4201	[FOR NEXT ERROR] A NEXT instruction was executed although no FOR instruction has been executed. Alternatively, there are more NEXT instructions than FOR instructions. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.		
4202	[FOR NEXT ERROR] More than 16 nesting levels are programmed. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Keep nesting levels at 16 or under.		
4203	[FOR NEXT ERROR] A BREAK instruction was executed although no FOR instruction has been executed prior to that. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed		DI IN-	
4210	[CAN'T EXECUTE(P)] The CALL instruction is executed, but there is no subroutine at the specified pointer. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Read the common information of the error using the peripheral device, check error step	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
4211	[CAN'T EXECUTE(P)] There was no RET instruction in the executed subroutine program. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	corresponding to its numerical value (program error location), and correct the problem.		
4212	[CAN'T EXECUTE(P)] The RET instruction exists before the FEND instruction of the main routine program. Collateral informationmmon Common Information:Program error location Individual Information: Diagnostic Timing When instruction executed			
4213	[CAN'T EXECUTE(P)] More than 16 nesting levels are programmed. Collateral informationmmon Common Information:Program error location Individual Information: Diagnostic Timing When instruction executed	Keep nesting levels at 16 or under.		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4220	[CAN'T EXECUTE(I)] Though an interrupt input occurred, the corresponding interrupt pointer does not exist. ■Collateral informationnmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed			
4221	[CAN'T EXECUTE(I)] An IRET instruction does not exist in the executed interrupt program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed			
4223	[CAN'T EXECUTE(I)] The IRET instruction exists before the FEND instruction of the main routine program. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Read the common information of the error using	RUN: Off	
4230	[INST. FORMAT ERR.] The number of CHK and CHKEND instructions is not equal. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	ERR.: Flicker CPU Status: Stop	QnA
4231	[INST. FORMAT ERR.] The number of IX and IXEND instructions is not equal. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed			
4235	[INST. FORMAT ERR.] The configuration of the check conditions for the CHK instruction is incorrect. Alternatively, a CHK instruction has been used in a low speed execution type program. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed			
4300	[EXTEND INST. ERR.] The designation of a MELSECNET/MINI-S3 master module control instruction was wrong. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4301	[EXTEND INST. ERR.] The designation of an AD57/AD58 control instruction was wrong. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.		
4400	[SFCP. CODE ERROR] No SFCP or SFCPEND instruction in SFC program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • STOP → RUN			
4410	[CAN'T SET(BL)] The block number designated by the SFC program exceeds the range. ■Collateral informationmmon Common Information:Program error location Individual Information:— ■Diagnostic Timing STOP → RUN			
4411	[CAN'T SET(BL)] Block number designations overlap in SFC program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • STOP → RUN	Write the program to the CPU module again using	RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	QnA
4420	[CAN'T SET(S)] A step number designated in an SFC program exceeds the range. ■Collateral informationmmon Common Information:Program error location Individual Information:— ■Diagnostic Timing STOP → RUN	GX Developer.		
4421	[CAN'T SET(S)] Total number of steps in all SFC programs exceed the maximum. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • STOP → RUN			
4422	[CAN'T SET(S)] Step number designations overlap in SFC program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • STOP → RUN			

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4500	[SFCP. FORMAT ERR.] The numbers of BLOCK and BEND instructions in an SFC program are not equal. ■Collateral informationmmon Common Information:Program error location Individual Information:— ■Diagnostic Timing STOP → RUN			
4501	[SFCP. FORMAT ERR.] The configuration of the STEP* to TRAN* to TSET to SEND instructions in the SFC program is incorrect. ■Collateral informationmmon • Common Information:Program error location • Individual Information:- ■Diagnostic Timing • STOP → RUN	Write the program to the CPU module again using the peripheral device.		
4502	[SFCP. FORMAT ERR.] The structure of the SFC program is illegal. • STEPI* instruction does not exist in the block of the SFC program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • STOP → RUN		RUN: Off ERR.: Flicker CPU Status: Stop RUN: Off/On ERR.: Flicker/On CPU Status: Stop/ Continue*1	
4503	[SFCP. FORMAT ERR.] The structure of the SFC program is illegal. • The step specified in the TSET instruction does not exist. • In jump transition, the host step number was specified as the destination step number. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • STOP → RUN	Write the program to the CPU module again using GX Developer. Read the common information of the error using GX Developer, and check and correct the error step corresponding to that value (program error location).		QnA
4504	[SFCP. FORMAT ERR.] The structure of the SFC program is illegal. • The step specified in the TAND instruction does not exist. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • STOP → RUN	Write the program to the CPU module again using GX Developer.		
4600	[SFCP. OPE. ERROR] The SFC program contains data that cannot be processed. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.		

^{*1} CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4601	[SFCP. OPE. ERROR] Exceeds device range that can be designated by the SFC program. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed [SFCP. OPE. ERROR] The START instruction in an SFC program is preceded by an END instruction. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Read common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off/On ERR: Flicker/On CPU Status: Stop/ Continue*1	
4610	[SFCP. EXE. ERROR] The active step information at presumptive start of the SFC program is incorrect. ■Collateral informationmmon Common Information:Program error location Individual Information:— ■Diagnostic Timing STOP → RUN	Read common information of the error using the peripheral device, check error step corresponding	RUN: On ERR.: On CPU Status: Continue	QnA
4611	[SFCP. EXE. ERROR] Key-switch was reset during RUN when presumptive start was designated for SFC program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • STOP → RUN	to its numerical value (program error location), and correct the problem. The program is automatically subjected to an initial start.		
4620	[BLOCK EXE. ERROR] Startup was executed at a block in the SFC program that was already started up. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off ERR.:	
4621	[BLOCK EXE. ERROR] Startup was attempted at a block that does not exist in the SFC program. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read the common information of the error using GX Developer, and check and correct the error step corresponding to that value (program error location). Turn ON if the special relay SM321 is OFF.	- Flicker CPU Status: Stop	

 $^{^{\}star}1$ $\,$ CPU operation can be set in the parameters at error occurrence. (LED indication varies.)

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
4630	[STEP EXE. ERROR] Startup was executed at a block in the SFC program that was already started up. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Read common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	RUN: Off ERR.: Flicker CPU Status: Stop	QnA
4631	STEP EXE. ERROR] • Startup was attempted at the step that does not exist in the SFC program. Or, the step that does not exist in the SFC program was specified for end. • Forced transition was executed based on the transition condition that does not exit in the SFC program. Or, the transition condition for forced transition that does not exit in the SFC program was canceled. ■Collateral informationmmon • Common Information:Program error location • Individual Information:— ■Diagnostic Timing • When instruction executed	Read the common information of the error using the peripheral device, and check and correct the error step corresponding to that value (program error location). Turn ON if the special relay SM321 is OFF.		
4632	[STEP EXE. ERROR] There were too many simultaneous active steps in blocks that can be designated by the SFC program. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	Read common information of the error using the peripheral device, check error step corresponding		
4633	[STEP EXE. ERROR] There were too many simultaneous active steps in all blocks that can be designated. Collateral informationmmon Common Information:Program error location Individual Information:— Diagnostic Timing When instruction executed	to its numerical value (program error location), and correct the problem.		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
5000 5001	The scan time of the initial execution type program exceeded the initial execution monitoring time specified in the PLC RAS setting of the PLC parameter. ■Collateral informationmmon Common Information:Time (value set) Individual Information:Time (value actually measured) ■Diagnostic Timing Always WDT ERROR] The scan time of the program exceeded the WDT value specified in the PLC RAS setting of the PLC parameter. ■Collateral informationmmon Common Information:Time (value set) Individual Information:Time (value actually measured) ■Diagnostic Timing Always ■Diagnostic Timing Always ■Diagnostic Timing Always ■Diagnostic Timing Always ■Diagnostic Timing ■	Read the individual information of the error from the peripheral device, check its value (time), and shorten the scan time. Change the initial execution monitoring time or the WDT value in the PLC RAS setting of the PLC parameter. Resolve the endless loop caused by jump transition.	RUN: Off ERR.: Flicker CPU Status: Stop	
5010	• Always [PRG. TIME OVER] The program scan time exceeded the constant scan setting time specified in the PLC RAS setting of the PLC parameter. ■Collateral informationmmon • Common Information:Time (value set) • Individual Information:Time (value actually measured) ■Diagnostic Timing • Always [PRG. TIME OVER] The low speed program execution time specified in the PLC RAS setting of the PLC parameter exceeded the excess time of the constant scan. ■Collateral informationmmon • Common Information:Time (value set) • Individual Information:Time (value actually measured) ■Diagnostic Timing • Always	Review the constant scan setting time. Review the constant scan setting time and low speed program execution time in the PLC parameter so that the excess time of constant scan can be fully secured.	RUN: On ERR.: On CPU Status: Continue	QnA
5011	[PRG. TIME OVER] The scan time of the low speed execution type program exceeded the low speed execution watch time specified in the PLC RAS setting of the PLC parameter dialog box. ■Collateral informationmmon Common Information:Time (value set) Individual Information:Time (value actually measured) ■Diagnostic Timing Always	Read the individual information of the error using the peripheral device, check the numerical value (time) there, and shorten scan time if necessary. Change the low speed execution watch time in the PLC RAS setting of the PLC parameter dialog box.		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
6000	[PRG. VERIFY ERR.] The control system and standby system in the redundant system do not have the same programs and parameters. (This can be detected from the standby system of the redundant system.) ■Collateral informationmmon • Common Information:File name • Individual Information:— ■Diagnostic Timing • Always	Synchronise the programs and parameters of the control system and standby system.	RUN: Off ERR.: Flicker CPU Status: Stop	
6010	[MODE. VERIFY ERR.] The operational status of the control system and standby system in the redundant system is not the same. (This can be detected from the standby system of the redundant system.) Collateral informationmmon Common Information:— Individual Information:— Diagnostic Timing Always	Synchronise the operation statuses of the control system and standby system.		
6100	[TRUCKINERR.] A CPU module tracking memory error was detected during initial. (This can be detected from the control system or standby system of the redundant system.) ■Collateral informationmmon • Common Information:— • Individual Information:— ■Diagnostic Timing • At power ON/At reset/STOP → RUN	Hardware fault of the CPU module. (Please contact your local nearest Mitsubishi or sales representative, explaining a detailed description of the problem. Change the CPU modules in order of the standby system CPU module and control system CPU module.)	RUN: On ERR.: On CPU Status: Continue	Q4AR
6101	[TRUCKIN ERR.] The CPU module detected an error during the handshake for tracking. (This can be detected from the control system or standby system of the redundant system.) ■Collateral informationmmon Common Information: Individual Information: ■Diagnostic Timing When an END instruction executed	Check the condition of the other stations.		
6200	[CONTROL EXE.] The standby system in a redundant system is switched to the control system. (This can be detected from the standby system of the redundant system.) ■Collateral informationmmon • Common Information:Reason(s) for system switching • Individual Information:— ■Diagnostic Timing • Always	Check the control system condition.	RUN: On ERR.: Off CPU Status: Continue	

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
6210	[CONTROL WAIT] The control system in a redundant system is switched to the standby system. (This can be detected from the standby system of the redundant system.) ■Collateral informationmmon • Common Information:Reason(s) for system switching • Individual Information:— ■Diagnostic Timing • Always	Check the control system condition.	RUN: On ERR.: Off CPU Status: Continue	Q4AR
6220	[CAN'T EXE. CHANGE] • Since the standby system is in an error or similar status in the redundant system, the control system cannot be switched to the standby system. • When an attempt was made to execute system switching, the control system could not be switched to the standby system due to a network error of the control system. (This can be detected from the control system of the redundant system.) ■Collateral informationmmon • Common Information:Reason(s) for system switching • Individual Information:─ ■Diagnostic Timing • At switching request	Check the standby system condition.	RUN: On ERR.: On CPU Status: Continue	
6221	[CAN'T EXE. CHANGE] Switching is disabled because of a bus switching module error. (This can be detected from the control system of the redundant system.) ■Collateral informationmmon • Common Information:Reason(s) for system switching • Individual Information:- ■Diagnostic Timing • At switching request	This is a bus switching module hardware fault. (Contact your local Mitsubishi representative.)		
6230	[DUAL SYS. ERROR] The link module mounted on the standby system CPU module is the remote master station. COllateral informationmmon Common Information: Individual Information: Diagnostic Timing Always	Check the system configuration status.		

Error Code	Error Contents and Cause	Corrective Action	LED Status CPU Status	Corresponding CPU
9000	[F****] Annunciator (F) was set ON Collateral informationmmon Common Information:Program error location Individual Information:Annunciator number Diagnostic Timing When instruction executed	Read the individual information of the error using the peripheral device, and check the program corresponding to the numerical value (annunciator number).	RUN: On ERR.: On/Off *2 CPU Status: Continue RUN: USER LED On ERR.: USER LED On CPU Status: Continue	
9010	[<chk>ERR ***-***] Error detected by the CHK instruction. Collateral informationmmon Common Information:Program error location Individual Information:Failure No. Diagnostic Timing When instruction executed</chk>	Read the individual information of the error using the peripheral device, and check the program corresponding to the numerical value (error number) there.	RUN: On ERR.: Off CPU Status: Continue RUN: USER LED On ERR.: USER LED On CPU Status: Continue	QnA

^{*2} For the Basic model QCPU, the special register (SD207 to DS209) for LED indication priority can turn off the indication. (The LED indication is always OFF for the High Performance model QCPU, Process CPU, Redundant CPU, and Universal model QCPU.)

6.4 Canceling of Errors

Q series CPU module can perform the cancel operation for errors only when the errors allow the CPU module to continue its operation.

To cancel the errors, follow the steps shown below.

- 1) Eliminate the cause of the error.
- 2) Store the error code to be canceled in the special register SD50.
- 3) Energize the special relay SM50 (OFF \rightarrow ON).
- 4) The error to be canceled is canceled.

After the CPU module is reset by the canceling of the error, the special relays, special registers, and LEDs associated with the error are returned to the status under which the error occurred.

If the same error occurs again after the cancellation of the error, it will be registered again in the error history.

When multiple enunciators(F) detected are canceled, the first one with No. F only is canceled.

Refer to the following manual for details of error canceling.

→ QCPU User's Manual (Function Explanation, Program Fundamentals

POINT

(1) When the error is canceled with the error code to be canceled stored in the SD50, the lower one digit of the code is neglected.

(Example)

If error codes 2100 and 2101 occur, and error code 2100 to cancel error code 2101.

If error codes 2100 and 2111 occur, error code 2111 is not canceled even if error code 2100 is canceled.

(2) Errors developed due to trouble in other than the CPU module are not canceled even if the special relay (SM50) and special register (SD50) are used to cancel the error.

(Example)

Since "SP. UNIT DOWN" is the error that occurred in the base unit (including the extension cable), intelligent function module, etc. the error cause cannot be removed even if the error is canceled by the special relay (SM50) and special register (SD50).

Refer to the error code list and remove the error cause.

7. TRANSPORTATION PRECAUTIONS

When transporting lithium batteries, make sure to treat them based on the transportation regulations.

7.1 Relevant Models

The batteries for the QnACPU are classified as shown in the table below.

Product Name	Model	Description	Handled As
QnA series battery	A6BAT	Lithium battery	Non-dangerous goods
QnA series battery	Q1MEM-128S,	Packed with lithium coin	
memory card	Q1MEM-128SE,	battery (BR2325)	
	Q1MEM-1MS,		
	Q1MEM-1MSE,		
	Q1MEM-1MSF,		
	Q1MEM-256S,		
	Q1MEM-256SE,		
	Q1MEM-256SF,		
	Q1MEM-2MS,		
	Q1MEM-2MSF,		
	Q1MEM-512S,		
	Q1MEM-512SE,		
	Q1MEM-512F,		
	Q1MEM-64S,		
	Q1MEM-64SE		

7.2 Transportation Guidelines

Products are packed properly in compliance with the transportation regulations prior to shipment. When repacking any of the unpacked products to transport it to another location, make sure to observe the IATA Dangerous Goods Regulations, IMDG Code and other local transportation regulations.

For details, please consult your transportation company.

MEMO		

Warranty

Mitsubishi will not be held liable for damage caused by factors found not to be the cause of Mitsubishi; machine damage or lost profits caused by faults in the Mitsubishi products; damage, secondary damage, accident compensation caused by special factors unpredictable by Mitsubishi; damages to products other than Mitsubishi products; and to other duties.

♠For safe use

- This product has been manufactured as a general-purpose part for general industries, and has not been designed or manufactured to be incorporated in a device or system used in purposes related to human life.
- Before using the product for special purposes such as nuclear power, electric power, aerospace, medicine or passenger movement vehicles, consult with Mitsubishi.
- This product has been manufactured under strict quality control. However, when installing
 the product where major accidents or losses could occur if the product fails, install
 appropriate backup or failsafe functions in the system.

Country/Region	Sales office/Tel	Country/Region	Sales office/Tel
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